# Instructor's Solution Manual with Transparency Masters 

# THE 8088 AND 8086 MICROPROCESSORS <br> Programming, Interfacing, <br> Software, Hardware, and Applications 

Fourth Edition

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Including the 80286, 80386, 80486, and Pentium ${ }^{\text {TM }}$ Processors

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## PREFACE

This manual contains solutions or answers to the assignment problems at the end of each chapter. These brief answers and solutions are strictly for use by the instructor.
Throughout the solutions the notation ---- after a signal name stands for overbar (NOT).
Also, included in the CD are transparency masters for many of the illustrations in the book.

Another supplements available from Prentice-Hall for the textbook is:

Laboratory Manual: ISBN: 0-13-045231-9<br>Laboratory Manual to Accompany<br>The 8088 and 8086 Microprocessors:<br>Programming, Interfacing, Software, Hardware, and Applications, Fourth Edition<br>Walter A. Triebel and Avtar Singh<br>c. 2003 Pearson Education, Inc.

Support products available from third parties are as follows:
Microsoft Macroassembler
Microsoft Corporation, Redmond, WA 98052
800-426-9400
PC $\mu \mathrm{LAB}$ - Laboratory Interface Circuit Test Unit
Microcomputer Directions, Inc.
P.O. Box 15127, Fremont, CA 94539

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## CHAPTER 1

## Section 1.1

1. Original IBM PC.
2. A system whose functionality expands by simply adding special function boards.
3. I/O channel.
4. Personal computer advanced technology.
5. Industry standard architecture.
6. Peripheral component interface (PCI) bus
7. A reprogrammable microcomputer is a general-purpose computer designed to run programs for a wide variety of applications, for instance, accounting, word processing, and languages such as BASIC.
8. Mainframe computer, minicomputer, and microcomputer.
9. The microcomputer is similar to the minicomputer in that it is designed to perform general-purpose data processing; however, it is smaller in size, has reduced capabilities, and cost less than a minicomputer.
10. Very large scale integration.

## Section 1.2

11. Input unit, output unit, microprocessing unit, and memory unit.
12. Microprocessing unit (MPU).
13. 16-bit.
14. Keyboard; mouse and scanner.
15. Monitor and printer.
16. Primary storage and secondary storage memory.
17. 360 K bytes; 10M bytes.
18. Read-only memory (ROM) and random access read/write memory (RAM).
19. 48 K bytes; 256 K bytes.
20. The Windows $98^{\mathrm{R}}$ program is loaded from the hard disk into RAM and then run. Since RAM is volatile, the operating system is lost whenever power is turned off.

## Section 1.3

21. 4-bit, 8-bit, 16-bit, 32-bit, and 64-bit.
22. 4004, 8008, 8086, 80386DX.
23. $8086,8088,80186,80188,80286$.
24. Million instructions per second.
25. 27 MIPS
26. Drystone program.
27. 39; 49.
28. $30,000,140,000,275,000,1,200,000,3,000,000$.
29. A special purpose microcomputer that performs a dedicated control function.
30. Event controller and data controller.
31. A multichip microcomputer is constructed from separate MPU, memory, and I/O ICs. On the other hand, in a single chip microcomputer, the MPU, memory, and I/O functions are all integrated into one IC.
32. 8088, 8086, 80286, 80386DX, 80486DX, and Pentium ${ }^{\mathrm{R}}$ processor.
33. Real mode and protected mode.
34. Upward software compatible means that programs written for the 8088 or 8086 will run directly on the $80286,80386 \mathrm{DX}$, and 80486DX.
35. Memory management, protection, and multitasking.
36. Floppy disk controller, communication controller, and local area network controller.

## Section 1.4

37. MSB and LSB.
38. $2^{-2}=1 / 4$
39. 1 and $2^{+5}=16_{10} ; 1$ and $2^{-4}=1 / 16$
40. (a) $6_{10}$, (b) $21_{10}$, (c) $127_{10}$.
41. $\operatorname{Min}=00000000_{2}=0_{10}$, $\operatorname{Max}=11111111_{2}=255_{10}$.
42. (a) $00001001_{2}$, (b) $00101010_{2}$, (c) $01100100_{2}$
43. $0000000111110100_{2}$
44. (a) $.1_{2}$
(b) $.01_{2}$
(c) $.01011_{2}$
45. $C$ and $16^{+2}=256_{10}$
46. $16^{+4}=65,536_{10}$
47. (a) 39 H , (b) E 2 H , (c) 03 A 0 H .
48. (a) $01101011_{2}$, (b) $11110011_{2}$, (c) $0000001010110000_{2}$.
49. $\mathrm{C} 6 \mathrm{H}, 198_{10}$.
50. $\mathrm{MSB}=1, \mathrm{LSB}=0$.
51. $8005 \mathrm{AH}, 1,048,666_{10}$.

## CHAPTER 2

## Section 2.1

1. Bus interface unit and execution unit.
2. BIU.
3. 20 bits; 16 bits.
4. 4 bytes; 6 bytes.
5. General-purpose registers, temporary operand registers, arithmetic logic unit (ALU), and status and control flags.

## Section 2.2

6. Aid to the assembly language programmer for understanding a microprocessor's software operation.
7. There purpose, function, operating capabilities, and limitations.
8. 14
9. $1,048,576$ (1M) bytes.
10. 65,536 ( 64 K ) bytes.

## Section 2.3

11. $\mathrm{FFFFF}_{16}$ and $00000_{16}$.
12. Bytes.
13. $00 \mathrm{FF}_{16}$; aligned word.
14. $44332211_{16}$; misaligned double word.
15. Address Contents

0A003H CDH
0A004H ABH
aligned word.
16. Address Contents
$0 \mathrm{~A} 001 \mathrm{H} \quad 78 \mathrm{H}$
0A002H 56 H
0A003H 34H
0A004H 12H
misaligned double word.

## Section 2.4

17. Unsigned integer, signed integer, unpacked BCD, packed BCD, and ASCII.
18. (a) 7 FH
(b) F 6 H
(c) 80 H
(d) 01 F 4 H
19. $(0 \mathrm{~A} 000 \mathrm{H})=\mathrm{F} 4 \mathrm{H}$
$(0 \mathrm{~A} 001 \mathrm{H})=01 \mathrm{H}$
20. $-1000=2$ 's complement of 1000
$=\mathrm{FC} 18 \mathrm{H}$
21. (a) 00000010,$00001001 ; 00101001$
(b) 00001000,$00001000 ; 10001000$
22. $(0 \mathrm{~B} 000 \mathrm{H})=09 \mathrm{H}$
$(0 \mathrm{~B} 001 \mathrm{H})=02 \mathrm{H}$
23. NEXT I
24. $(0 \mathrm{C} 000 \mathrm{H})=34 \mathrm{H}$
$(0 \mathrm{C} 001 \mathrm{H})=33 \mathrm{H}$
$(0 \mathrm{C} 002 \mathrm{H})=32 \mathrm{H}$
$(0 \mathrm{C} 003 \mathrm{H})=31 \mathrm{H}$

## Section 2.5

25. 64Kbytes.
26. Code segment (CS) register, stack segment (SS) register, data segment (DS) register, and extra segment (ES) register.
27. CS.
28. Up to 256 Kbytes .
29. Up to 128 Kbytes.

## Section 2.6

30. Pointers to interrupt service routines.
31. $80_{16}$ through FFFEF $_{16}$.
32. Instructions of the program can be stored anywhere in the general-use part of the memory address space.
33. Control transfer to the reset power-up initialization software routine.

## Section 2.7

34. The instruction pointer is the offset address of the next instruction to be fetched by the 8088 relative to the current value in CS.
35. The instruction is fetched from memory; decoded within the 8088; operands are read from memory or internal registers; the operation specified by the instruction is performed on the data; and results are written back to either memory or an internal register.
36. IP is incremented such that it points to the next sequential word of instruction code.

## Section 2.8

37. Accumulator (A) register, base (B) register, count (C) register, and data (D) register.
38. With a postscript $X$ to form $A X, B X, C X$, and $D X$.
39. DH and DL.
40. Count for string operations and count for loop operations.

## Section 2.9

41. Offset address of a memory location relative to a segment base address.
42. Base pointer (BP) and stack pointer (SP).
43. SS
44. DS
45. Source index register; destination index register.
46. The address in SI is the offset to a source operand and DI contains the offset to a destination operand.

## Section 2.10

47. Flag Type

CF Status
PF Status
AF Status
ZF Status
SF Status
OF Status

TF Control
IF Control
DF Control
48. $\mathrm{CF}=1$, if a carry-out/borrow-in results for the MSB during the execution of an arithmetic instruction. Else it is 0 .
$\mathrm{PF}=1$, if the result produced by execution of an instruction has even parity. Else it is 0 .
$\mathrm{AF}=1$, if there is a carry-out/borrow-in for the fourth bit during the execution of an arithmetic instruction.
$\mathrm{ZF}=1$, if the result produced by execution of an instruction is zero. Else it is 0 .
$\mathrm{SF}=1$, if the result produced by execution of an instruction is negative. Else it is 0 .
$\mathrm{OF}=1$, if an overflow condition occurs during the execution of an arithmetic instruction. Else it is 0 .
49. Instructions can be used to test the state of these flags and, based on their setting, modify the sequence in which instructions of the program are executed.
50. Trap flag
51. DF
52. Instructions are provided that can load the complete register or modify specific flag bits.

## Section 2.11

53. 20 bits.
54. Offset and segment base.
55. (a) 11234 H
(b) 0 BBCDH
(c) A 32 CFH
(d) C 2612 H
56. (a) $?=0123 \mathrm{H}$
(b) $?=2210 \mathrm{H}$
(c) ? $=3570 \mathrm{H}$
(d) ? $=2600 \mathrm{H}$
57. $021 \mathrm{AC}_{16}$
58. $\mathrm{A} 000_{16}$
59. $1234_{16}$

## Section 2.12

60. The stack is the area of memory used to temporarily store information (parameters) to be passed to subroutines and other information such as the contents of IP and CS that is needed to return from a called subroutine to the main part of the program.
61. CFF00 ${ }_{16}$
62. 128 words.
63. FEFEH $\rightarrow$ (SP)

$$
\begin{aligned}
& (\mathrm{AH})=\mathrm{EEH} \rightarrow(\mathrm{CFEFFH}) \\
& (\mathrm{AL})=11 \mathrm{H} \rightarrow(\mathrm{CFEFEH})
\end{aligned}
$$

## Section 2.13

64. Separate.
65. 64-Kbytes.
66. Page 0 .

## CHAPTER 3

## Section 3.1

1. Software.
2. Program.
3. Operating system.
4. 80386DX machine code.
5. Instructions encoded in machine language are coded in 0 s and 1 s , while assembly language instructions are written with alphanumeric symbols such as MOV, ADD, or SUB.
6. Mnemonic that identifies the operation to be performed by the instruction; ADD and MOV.
7. The data that is to be processed during execution of an instruction; source operand and destination operand.
8. START; ;Add BX to AX
9. An assembler is a program that is used to convert an assembly language source program to its equivalent program in machine code. A compiler is a program that converts a program written in a high-level language to equivalent machine code.
10. Programs written is assembly language or high level language statements are called source code. The machine code output of an assembler or compiler is called object code.
11. It takes up less memory and executes faster.
12. A real-time application is one in which the tasks required by the application must be completed before any other input to the program occurs that can alter its operation.
13. Floppy disk subsystem control and communications to a printer; code translation and table sort routines.

## Section 3.2

14. Application specification.
15. Algorithm; software specification.
16. A flowchart is a pictorial representation that outlines the software solution to a problem.
17. 


18. Editor.
19. Assembler.
20. Macroassembler.
21. Linker.
22.
(a) Creating a source program
(b) Assembling a source program into an object module
(c) Producing a run module
(d) Verifying/debugging a solution
23.
(a) PROG_A.ASM
(b) PROG_A.LST and PROG_A.OBJ
(c) PROG_A.EXE and PROG_A.MAP

## Section 3.3

24. 117. 
1. Data transfer instructions, arithmetic instructions, logic instructions, string manipulation instructions, control transfer instructions, and processor control instructions.

## Section 3.4

26. Execution of the move instruction transfers a byte or a word of data from a source location to a destination location.

## Section 3.5

27. An addressing mode means the method by which an operand can be specified in a register or a memory location.
28. Register operand addressing mode

Immediate operand addressing mode
Memory operand addressing modes
29. Base, index, and displacement.
30. Direct addressing mode

Register indirect addressing mode
Based addressing mode
Indexed addressing mode
Based-indexed addressing mode
31. Instruction
(a)
(b)
(c) Register indirect
(d)

Destination
Register
Register
Register

Source
Register
Immediate
Register
Register indirect

| （e） | Based | Register |
| :--- | :--- | :--- |
| $(\mathbf{f})$ | Indexed | Register |
| $(\mathbf{g})$ | Based－indexed | Register |

32. 

（a） $\mathrm{PA}=0 \mathrm{~B} 200_{16}$
（b） $\mathrm{PA}=0 \mathrm{~B} 100_{16}$
（c） $\mathrm{PA}=0 \mathrm{~B} 700_{16}$
（d） $\mathrm{PA}=0 \mathrm{~B} 600_{16}$
（e） $\mathrm{PA}=0 \mathrm{~B} 900_{16}$

## CHAPTER 4

## Section 4.1

1． 6 bytes．
2． $0000001111000010_{2}=03 \mathrm{C} 2 \mathrm{H}$
3．（a） $1000100100010101_{2}=8915 \mathrm{H}$ ；（b） $1000100100011000_{2}=8918 \mathrm{H}$ ；
（c） $100010100101011100010000_{2}=8 \mathrm{~A} 5710 \mathrm{H}$
4．（a） $00011110_{2}=1 \mathrm{EH}$ ；（b） $1101001011000011_{2}=\mathrm{D} 2 \mathrm{C} 3 \mathrm{H}$ ；
（c） $11000001100011010000010010_{2}=03063412 \mathrm{H}$

## Section 4.2

5.3 bytes．

6． 24 bytes．

## Section 4.3

7．The DEBUG program allows us to enter a program into the PC＇s memory，execute it under control，view its operation，and modify it to fix errors．
8．Yes．
9．Error．
10.
－R CX（」）
CX XXXX
：0010（」）
11.
－R F（」）
NV UP EI PL NZ NA PO NC－PE（ل）
12.
－R
（．」）

## Section 4.4

13. 

－D CS：0000 000F
14.
－E CS：0（．ل）
1342：0000 CD．20．00．40．00．9A．EE．FE．
1342：0008 1D．F0．F5．02．A7．0A．2E．03．（ل）
After a byte of data is displayed，the space bar is depressed to display the next byte．The values displayed may not be those shown but will be identical to those displayed with the DUMP command．
15.
－E CS： 100 FF FF FF FF FF
（」）
16.
－E SS：（SP） 0 ．．．．．． 0 （ 32 zeros）（ل」）
17.

- F CS：100 10511 （」）
- F CS：106 10B 22 （」）
- F CS：10C 11133 （」）
- F CS：112 11744 （」）
- F CS：118 11D 55 （ل」）
- E CS：105（」）

CS：0105 XX．FF（ل）
－E CS：113（」）
－CS：0113 XX．FF（لـ）

- D CS：100 11D（」）
- S CS： 100 11D FF（」）


## Section 4.5

18．Input command and output command．
19．Contents of the byte－wide input port at address $0123_{16}$ is input and displayed on the screen．
20.

O 124 5A（，（ل）

## Section 4.6

21．The sum and difference of two hexadecimal numbers．
22． 4 digits．
23.

H FA 5A（」）

## Section 4.7

24. 

－E CS：100 32 0E 3412
－U CS：100 103
（）
1342：100 320E3412 XOR CL，［1234］

```
-W CS:100 1 50 1
    (」)
25.
-L CS:400 150 1 (」)
-U CS:400 403 (.)
1342:0400 320E3412 XOR CL,[1234]
```


## Section 4.8

26. 

－A CS：100（」）
1342：0100 MOV［DI］，DX（」）
1342：0102（」）
27.
－A CS：200（」）
1342：0200 ROL BL，CL（」）
1342：0202（」）
－U CS：200 201
1342：0200 D2C3 ROL BL，CL

## Section 4.9

28. 

－L CS：300 1501 （」）
－U CS：300 303
－R CX（」）
CX XXXX
：000F（」）

- E DS：1234 FF（」）
- T＝CS：300（」）
- D DS：1234 1235 （」）

29. 

- N A：BLK．EXE（」）
- L CS：200（」）
- R DS（」）

DS 1342
：2000（」）

- F DS： 100 10F FF（」）
- F DS：120 12F 00 （」）
- D DS：100 10F（」）

2000：0100 FF FF FF FF FF FF FF FF－FF FF FF FF FF FF FF FF
－D DS：120 12F（」）

2000：0120 00000000000000 00－00 00000000000000
－R DS
（）

DS 2000


## Section 4.10

30. A syntax error is an error in the rules of coding the program. On the other hand, an execution error is an error in the logic of the planned solution for the problem.
31. Bugs.
32. Debugging the program.
33. 

-N A:BLK.EXE (」)
-L CS:200 (」)
-U CS:200 217
1342:0200 B80020 MOV AX,2000
1342:0203 8ED8 MOV DS,AX
1342:0205 BE0001 MOV SI,0100
1342:0208 BF2001 MOV DI,0120
1342:020B B91000 MOV CX,0010
1342:020E 8A24 MOV AH,[SI]
1342:0210 8825 MOV [DI],AH
1342:0212 46 INC SI

| 1342：0213 47 | INC | DI |
| :---: | :---: | :---: |
| 1342：0214 49 | DEC | CX |
| 1342：0215 75F7 | JNZ | 020E |
| 1342：021790 | NOP |  |
| －R DS | （，ل） |  |
| DS 1342 |  |  |
| ：2000 | （」） |  |
| －F DS： 100 10F FF | （」） |  |
| －F DS：120 12F 00 | （」） |  |
| －R DS | （ل） |  |
| DS 2000 |  |  |
| ：1342 | （．」） |  |
| －G＝CS：200 20E | （，」） |  |

$\mathrm{AX}=2000 \mathrm{BX}=0000 \mathrm{CX}=0010 \mathrm{DX}=0000 \mathrm{SP}=\mathrm{FFEE}$ BP＝0000 SI＝0100 DI＝0120 DS＝2000 ES＝1342 SS＝1342 CS＝1342 IP＝020E NV UP EI PL NZ NA PO NC 1342：020E 8A24 MOV AH，［SI］DS：0100＝FF
－D DS：120 12F（」）

2000：0120 $0000000000000000-0000000000000000$
－G 212
（」）
AX＝FF00 BX＝0000 CX＝0010 DX＝0000 SP＝FFEE BP＝0000 SI＝0100 DI＝0120 DS＝2000 ES＝1342 SS＝1342 CS＝1342 IP＝0212 NV UP EI PL NZ NA PO NC 1342：0212 46 INC SI
－D DS：120 12F（」）
2000：0120 FF 000000000000 00－00 00000000000000
－G 215
（」）
AX＝FF00 BX＝0000 CX＝000F DX＝0000 SP＝FFEE BP＝0000 SI＝0101 DI＝0121
DS＝2000 ES＝1342 SS＝1342 CS＝1342 IP＝0215 NV UP EI PL NZ AC PE NC 1342：0215 75F7 JNZ 020E
－G 20E（」）
AX＝FF00 BX＝0000 CX＝000F DX＝0000 SP＝FFEE BP＝0000 SI＝0101 DI＝0121
DS＝2000 ES＝1342 SS＝1342 CS＝1342 IP＝020E NV UP EI PL NZ AC PE NC
1342：020E 8A24 MOV AH，［SI］DS：0101＝FF
－G 215
$\mathrm{AX}=\mathrm{FF} 00 \mathrm{BX}=0000 \mathrm{CX}=000 \mathrm{E}$ DX＝0000 SP＝FFEE BP＝0000 SI＝0102 DI＝0122
DS＝2000 ES＝1342 SS＝1342 CS＝1342 IP＝0215 NV UP EI PL NZ NA PO NC 1342：0215 75F7 JNZ 020E
－D DS：120 12F（」）
2000：0120 FF FF 0000000000 00－00 00000000000000
－G 20E
（」）
AX＝FF00 BX＝0000 CX＝000E DX＝0000 SP＝FFEE BP＝0000 SI＝0102 DI＝0122
DS＝2000 ES＝1342 SS＝1342 CS＝1342 IP＝020E NV UP EI PL NZ NA PO NC
1342：020E 8A24 MOV AH，［SI］DS：0102＝FF
－G 217
（」）
AX＝FF00 BX＝0000 CX＝0000 DX＝0000 SP＝FFEE BP＝0000 SI＝0110 DI＝0130 DS＝2000 ES＝1342 SS＝1342 CS＝1342 IP＝0217 NV UP EI PL ZR NA PE NC

1342:0217 90 NOP
-D DS:120 12F (」)
2000:0120 FF FF FF FF FF FF FF FF-FF FF FF FF FF FF FF FF

## CHAPTER 5

## Section 5.1

1. 

(a) Value of immediate operand 0110 H is moved into AX.
(b) Contents of AX are copied into DI.
(c) Contents of AL are copied into BL.
(d) Contents of AX are copied into memory address DS: 0100 H .
(e) Contents of AX are copied into the data segment memory location pointed to by (DS) $0+(\mathrm{BX})+(\mathrm{DI})$.
(f) Contents of AX are copied into the data segment memory location pointed to by $(\mathrm{DS}) 0+(\mathrm{DI})+4 \mathrm{H}$.
(g) Contents of AX are copied into the data segment memory location pointed to by $(\mathrm{DS}) 0+(\mathrm{BX})+(\mathrm{DI})+4 \mathrm{H}$.
2.
(a) Value 0110 H is moved into AX.
(b) 0110 H is copied into DI.
(c) 10 H is copied into BL.
(d) 0110 H is copied into memory address DS:0100H.
(e) 0110 H is copied into memory address DS:0120H.
(f) 0110 H is copied into memory address DS: 0114 H .
(g) 0110 H is copied into memory address DS:0124H.
3. MOV AX,1010H

MOV ES,AX
4. MOV [1000H],ES
5. Destination operand CL is specified as a byte, and source operand $A X$ is specified as a word. Both must be specified with the same size.
6.
(a) Contents of AX and BX are swapped.
(b) Contents of BX and DI are swapped.
(c) Contents of memory location with offset DATA in the current data segment and register AX are swapped.
(d) Contents of the memory location pointed to by $(\mathrm{DS}) 0+(\mathrm{BX})+(\mathrm{DI})$ are swapped with those of register AX.
7. $10750 \mathrm{H}+100 \mathrm{H}+10 \mathrm{H}=10860 \mathrm{H}$.
8. AL is loaded from the physical address $10000_{16}+0100_{16}+0010_{16}=10110_{16}$.
9. LDS AX, $[0200 \mathrm{H}]$.

Section 5.2
10. (a) $00101101_{2}$. (b) $100101011_{2}$.
11. $110011000_{2}, 198 \mathrm{H}, 408_{10}$.
12. (a) $00000011_{2}$. (b) $10001101_{2}$.
13. (a) $00001001_{2}$. (b) $01101001_{2}$.
14. $00001111_{2}, 0 \mathrm{FH}, 15_{10}$.
15.
(a) 00 FFH is added to the value in AX .
(b) Contents of AX and CF are added to the contents of SI.
(c) Contents of DS: 100 H are incremented by 1 .
(d) Contents of BL are subtracted from the contents of DL.
(e) Contents of DS:200H and CF are subtracted from the contents of DL.
(f) Contents of the byte-wide data segment storage location pointed to by (DS) $0+(\mathrm{DI})+$ (BX) are decremented by 1 .
(g) Contents of the byte-wide data segment storage location pointed to by (DS)0 + (DI) + 10 H are replaced by its negative.
(h) Contents of word register DX are signed-multiplied by the word contents of AX. The double word product that results is produced in DX, AX.
(i) Contents of the byte storage location pointed to by (DS) $0+(\mathrm{BX})+(\mathrm{SI})$ are multiplied by the contents of AL.
(j) Contents of AX are signed-divided by the byte contents of the data segment storage location pointed to by $(\mathrm{DS}) 0+(\mathrm{SI})+30 \mathrm{H}$.
(k) Contents of AX are signed-divided by the byte contents of the data segment storage location pointed to by $(\mathrm{DS}) 0+(\mathrm{BX})+(\mathrm{SI})+30 \mathrm{H}$.
16.
(a) $(\mathrm{AX})=010 \mathrm{FH}$
(b) $(\mathrm{SI})=0111 \mathrm{H}$
(c) $(\mathrm{DS}: 100 \mathrm{H})=11 \mathrm{H}$
(d) $(\mathrm{DL})=20 \mathrm{H}$
(e) $(\mathrm{DL})=0 \mathrm{FH}$
(f) $(\mathrm{DS}: 220 \mathrm{H})=2 \mathrm{FH}$
(g) $(\mathrm{DS}: 210 \mathrm{H})=\mathrm{C} 0 \mathrm{H}$
(h) $(\mathrm{AX})=0400 \mathrm{H}$
$(\mathrm{DX})=0000 \mathrm{H}$
(i) $(\mathrm{AL})=\mathrm{FOH}$
$(\mathrm{AH})=\mathrm{FFH}$
(j) $(\mathrm{AL})=02 \mathrm{H}$
$(\mathrm{AH})=00 \mathrm{H}$
(k) $(\mathrm{AL})=08 \mathrm{H}$
$(\mathrm{AH})=00 \mathrm{H}$
17. ADC DX,111FH
18. SBB $A X,[B X]$
19. ADD SI, 2 H ,
or
INC SI
INC SI
20. $(\mathrm{AH})=$ remainder $=3_{16},(\mathrm{AL})=$ quotient $=12_{16}$, therefore, $(\mathrm{AX})=0312_{16}$.
21. DAA.
22. AAS.
23. $(A X)=F F A 0 H$.
24. $(\mathrm{AX})=7 \mathrm{FFFH},(\mathrm{DX})=0000 \mathrm{H}$.
25. Let us assume that the memory locations NUM1, NUM2, and NUM3 are in the same data segment.

MOV AX, DATA_SEG ;Establish data segment
MOV DS, AX
MOV AL, [NUM2] ;Get the second BCD number
SUB AL, [NUM1] ;Subtract the binary way
DAS ;Apply BCD adjustment
MOV [NUM3], AL ;Save the result.
Note that storage locations NUM1, NUM2, and NUM3 are assumed to have been declared as byte locations.

## Section 5.3

26. (a) $00010000_{2}$. (b) $01001100_{2}$.
27. (a) $00011101_{2}$. (b) $11011111_{2}$.
28. $01010101_{2}, 55 \mathrm{H}$.
29. $00011000_{2}, 18 \mathrm{H}$.
30. 

(a) 0FH is ANDed with the contents of the byte-wide memory address DS:300H.
(b) Contents of DX are ANDed with the contents of the word storage location pointed to by (DS) $0+(\mathrm{SI})$.
(c) Contents of AX are ORed with the word contents of the memory location pointed to by (DS) $0+(\mathrm{BX})+(\mathrm{DI})$.
(d) FOH is ORed with the contents of the byte-wide memory location pointed to by (DS) $0+(\mathrm{BX})+(\mathrm{DI})+10 \mathrm{H}$.
(e) Contents of the word-wide memory location pointed to by $(\mathrm{DS}) 0+(\mathrm{SI})+(\mathrm{BX})$ are exclusive-ORed with the contents of AX.
(f) The bits of the byte-wide memory location DS:300H are inverted.
(g) The bits of the word memory location pointed to by $(\mathrm{DS}) 0+(\mathrm{BX})+(\mathrm{DI})$ are inverted.
31.
(a) $(\mathrm{DS}: 300 \mathrm{H})=0 \mathrm{AH}$
(b) $(\mathrm{DX})=\mathrm{A} 00 \mathrm{AH}$
(c) $($ DS:210H $)=$ FFFFH
(d) $(\mathrm{DS}: 220 \mathrm{H})=\mathrm{F} 5 \mathrm{H}$
(e) $(\mathrm{AX})=\mathrm{AA} 55 \mathrm{H}$
(f) $(\mathrm{DS}: 300 \mathrm{H})=55 \mathrm{H}$
(g) $(\mathrm{DS}: 210 \mathrm{H})=55 \mathrm{H},(\mathrm{DS}: 211 \mathrm{H})=55 \mathrm{H}$
32. AND DX,0080H
33. AND WORD PTR [100H], 0080 H .
34. The new contents of $A X$ are the 2's complement of its old contents.
35. XOR AH, 80 H .
36. MOV AL,[CONTROL_FLAGS] AND AL,81H

## MOV [CONTROL_FLAGS],AL

37. The first instruction reads the byte of data from memory location CONTROL_FLAGS and loads it into BL. The AND instruction masks all bits but $\mathrm{B}_{3}$ to 0 ; the XOR instruction toggles bit $B_{3}$ of this byte. That is, if the original value of $B_{3}$ equals logic 0 , it is switched to 1 or if it is logic 1 it is switched to 0 . Finally, the byte of flag information is written back to memory. This instruction sequence can be used to selectively complement one or more bits of the control flag byte.

## Section 5.4

38. 

(a) Contents of DX are shifted left by a number of bit positions equal to the contents of CL. LSBs are filled with zeros, and CF equals the value of the last bit shifted out of the MSB position.
(b) Contents of the byte-wide memory location DS:400H are shifted left by a number of bit positions equal to the contents of CL. LSBs are filled with zeros, and CF equals the value of the last bit shifted out of the MSB position.
(c) Contents of the byte-wide memory location pointed to by (DS)0 + (DI) are shifted right by 1 bit position. MSB is filled with zero, and CF equals the value shifted out of the LSB position.
(d) Contents of the byte-wide memory location pointed to by (DS)0 $+(\mathrm{DI})+(\mathrm{BX})$ are shifted right by a number of bit positions equal to the contents of CL. MSBs are filled with zeros, and CF equals the value of the last bit shifted out of the LSB position.
(e) Contents of the word-wide memory location pointed to by (DS) $0+(\mathrm{BX})+$ (DI) are shifted right by 1 bit position. MSB is filled with the value of the original MSB and CF equals the value shifted out of the LSB position.
(f) Contents of the word-wide memory location pointed to by (DS)0 0 (BX) $+(\mathrm{DI})+10 \mathrm{H}$ are shifted right by a number of bit positions equal to the contents of CL. MSBs are filled with the value of the original MSB, and CF equals the value of the last bit shifted out of the LSB position.
39.
(a) $(\mathrm{DX})=2220 \mathrm{H},(\mathrm{CF})=0$
(b) $(\mathrm{DS}: 400 \mathrm{H})=40 \mathrm{H},(\mathrm{CF})=1$
(c) $(\mathrm{DS}: 200 \mathrm{H})=11 \mathrm{H},(\mathrm{CF})=0$
(d) $(\mathrm{DS}: 210 \mathrm{H})=02 \mathrm{H},(\mathrm{CF})=1$
(e) $(\mathrm{DS}: 210 \mathrm{H}, 211 \mathrm{H})=\mathrm{D} 52 \mathrm{AH},(\mathrm{CF})=1$
(f) $(\mathrm{DS}: 220 \mathrm{H}, 221 \mathrm{H})=02 \mathrm{ADH},(\mathrm{CF})=0$
40. SHL CX,1
41. MOV CL, 08 H

SHL WORD PTR [DI],CL
42. The original contents of $A X$ must have the four most significant bits equal to 0 .
43. $(\mathrm{AX})=\mathrm{F} 800 \mathrm{H} ; \mathrm{CF}=1$.
44. The first instruction reads the byte of control flags into AL. Then all but the flag in the most significant bit location $B_{7}$ are masked off. Finally, the flag in $B_{7}$ is shifted to the left and into the carry flag. When the shift takes place, $\mathrm{B}_{7}$ is shifted into CF ; all other bits
in AL move one bit position to the left, and the LSB locations are filled with zeros. Therefore, the contents of AL become 00 H .
45

| MOV AX, [ASCII_DATA] | ;Get the word into AX |
| :--- | :--- |
| MOV BX,AX | ;and BX |
| MOV CL,08H | ;(CL) = bit count |
| SHR BX,CL | ;(BX) = higher character |
| AND AX,00FFH | ;(AX) = lower character |
| MOV [ASCII_CHAR_L],AX | ;Save lower character |
| MOV [ASCII_CHAR_H],BX | ;Save higher character |

## Section 5.5

## 46.

(a) Contents of DX are rotated left by a number of bit positions equal to the contents of CL. As each bit is rotated out of the MSB position, the LSB position and CF are filled with this value.
(b) Contents of the byte-wide memory location DS: 400 H are rotated left by a number of bit positions equal to the contents of CL. As each bit is rotated out of the MSB position, it is loaded into CF , and the prior contents of CF are loaded into the LSB position.
(c) Contents of the byte-wide memory location pointed to by (DS)0 + (DI) are rotated right by 1 bit position. As the bit is rotated out of the LSB position, the MSB position and CF are filled with this value.
(d) Contents of the byte-wide memory location pointed to by (DS)0 0 (DI) $+(\mathrm{BX})$ are rotated right by a number of bit positions equal to the contents of CL. As each bit is rotated out of the LSB position, the MSB position and CF are filled with this value.
(e) Contents of the word-wide memory location pointed to by (DS) $0+(\mathrm{BX})+(\mathrm{DI})$ are rotated right by 1 bit position. As the bit is rotated out of the LSB location, it is loaded into CF , and the prior contents of CF are loaded into the MSB position.
(f) Contents of the word-wide memory location pointed to by $(\mathrm{DS}) 0+(\mathrm{BX})+(\mathrm{DI})+10 \mathrm{H}$ are rotated right by a number of bit positions equal to the contents of CL. As each bit is rotated out of the LSB position, it is loaded into CF , and the prior contents of CF are loaded into the MSB position.
47.
(a) $(\mathrm{DX})=2222 \mathrm{H},(\mathrm{CF})=0$
(b) $(\mathrm{DS}: 400 \mathrm{H})=5 \mathrm{AH},(\mathrm{CF})=1$
(c) $(\mathrm{DS}: 200 \mathrm{H})=11 \mathrm{H},(\mathrm{CF})=0$
(d) $(\mathrm{DS}: 210 \mathrm{H})=\mathrm{AAH},(\mathrm{CF})=1$
(e) $(\mathrm{DS}: 210 \mathrm{H}, 211 \mathrm{H})=\mathrm{D} 52 \mathrm{AH},(\mathrm{CF})=1$
(f) $(\mathrm{DS}: 220 \mathrm{H}, 221 \mathrm{H})=\mathrm{AAADH},(\mathrm{CF})=0$
48. RCL WORD PTR [BX],1
49. MOV BL,AL ; Move bit 5 to bit 0 position

MOV CL,5
SHR BX,CL
AND BX,1 ; Mask the other bit
50. MOV AX,[ASCII_DATA] ;Get the word into AX

MOV BX,AX

MOV CL,08H
ROR BX,CL
AND AX,00FFH
AND BX,00FFH
MOV [ASCII_CHAR_L],AX
MOV [ASCII_CHAR_H],BX
;(CL) = bit count
;Rotate to position the higher character ;(AX) = lower character
; $(\mathrm{BX})=$ higher character
;Save lower character
;Save higher character

## Advanced Problems:

51. MOV AX,DATA_SEG ;Establish the data segment

MOV DS,AX
MOV AL,[MEM1] ;Get the given code at MEM1
MOV BX,TABL1
XLAT
MOV [MEM1],AL
MOV AL,[MEM2] ;Repeat for the second code at MEM2
MOV BX,TABL2
XLAT
MOV [MEM2],AL
52. MOV AX,0 ;Set up the data segment

MOV DS,AX
MOV BX,0A10H
MOV DX,[0A00H]
ADD DX,[0A02H]
MOV [BX],DX
MOV DX,[0A00H]
SUB DX,[0A02H]
ADD BX,2 ;Save the difference
MOV [BX],DX
MOV AX,[0A00H] ;Generate the product
MUL [0A02H]
ADD BX,2
;Save LS part of the product
MOV [BX],AX
ADD BX,2 ;Save MS part of the product
MOV [BX],DX
MOV AX,[0A00H] ;Generate the quotient
DIV AX,[0A02H]
ADD BX,2 ;Save the quotient
MOV [BX],AX
;Set up pointer for results
;Generate the sum
;Save the sum
;Generate the difference
53.
; $($ RESULT $)=(\mathrm{AL}) \bullet($ NUM1 $)+(\mathrm{AL}) \bullet($ NUM2--- $)+(\mathrm{BL})$
NOT [NUM2] ;(NUM2) $\leftarrow$ (NUM2---)
MOV CL, AL
AND CL, [NUM2] ; (CL) $\leftarrow($ AL) • (NUM2---)
OR CL, BL ; (CL) $\leftarrow(\mathrm{AL}) \bullet($ NUM2--- $)+(\mathrm{BL})$
AND AL, [NUM1] ;(AL) $\leftarrow(A L) \bullet(N U M 1)$

OR AL, CL
MOV [RESULT],AL ;(RESULT)=(AL)•(NUM1)+(AL)•(NUM2---)+(BL)
54. Assume that all numbers are small enough so that shifting to the left does not generate an overflow. Further we will accept the truncation error due to shifts to the right.

```
MOV DX,AX ;(DX)\leftarrow (AX)
MOV CL,3
SHL DX,CL
SUB DX,AX
MOV SI,BX ;(SI)\leftarrow5(BX)
MOV CL,2
SHL SI,CL
ADD SI,BX
SUB DX,SI ;(DX)\leftarrow7(AX) - 5(BX)
MOV SI,BX ;(SI)\leftarrow(BX)/8
MOV CL,3
SAR SI,CL
SUB DX,SI ;(DX) \leftarrow7(AX) - 5(BX) - (BX)/8
MOV AX,DX ;(AX) \leftarrow7(AX) - 5(BX) - (BX)/8
```


## CHAPTER 6

## Section 6.1

1. Executing the first instruction causes the contents of the status register to be copied into AH. The second instruction causes the value of the flags to be saved in memory location (DS) $0+(\mathrm{BX})+(\mathrm{DI})$.
2. The first instruction loads AH with the contents of the memory location (DS) $0+(\mathrm{BX})$ $+(\mathrm{SI})$. The second instruction copies the value in AH to the status register.
3. STC; CLC.
4. CLI
5. CLI

MOV AX,0H ;Establish data segment
MOV DS,AX
MOV BX,0A000H ;Establish destination pointer
LAHF ;Get flags
MOV [BX],AH ;and save at 0A000H
CLC ;Clear CF

## Section 6.2

6. Both instructions subtract the operands and change the flags as per the result. In a compare instruction, the result of the subtraction does not affect either operand. However, in a subtract instruction, the result of the subtraction is saved in the destination operand.
7. 

(a) The byte of data in AL is compared with the byte of data in memory at address

DS: 100 H by subtraction, and the status flags are set or reset to reflect the result.
(b) The word contents of the data storage memory location pointed to by (DS) $0+(\mathrm{SI})$ are compared with the contents of AX by subtraction, and the status flags are set or reset to reflect the results.
(c) The immediate data 1234 H are compared with the word contents of the memory location pointed to by (DS)0 + (DI) by subtraction, and the status flags are set or reset to reflect the results.
8.

| Instruction | (ZF) | (SF) | (CF) | (AF) | (OF) | (PF) |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Initial state | X | X | X | X | X | X |
| (a) CMP [0100H],AL | 0 | 1 | 0 | 1 | 0 | 0 |
| (b) CMP AX,[SI] | 0 | 0 | 0 | 0 | 1 | 1 |
| (c) CMP WORD PTR [DI],1234H | 1 | 0 | 0 | 0 | 0 | 1 |

9. Instruction (ZF) (CF) Initial state
00
After MOV BX, $1111 \mathrm{H} \quad 0 \quad 0$

After MOV AX,0BBBBH 0 0 After CMP BX,AX $0 \quad 1$

## Section 6.3

10. When an unconditional jump instruction is executed, the jump always takes place. On the other hand, when a conditional jump instruction is executed, the jump takes place only if the specified condition is satisfied.
11. IP; CS and IP.
12. 8-bit; 16-bit; 16-bit.
13. Intersegment.
14. 

(a) Intrasegment; Short-label; The value 10 H is placed in IP.
(b) Intrasegment; Near-label; The value 1000 H is copied into IP.
(c) Intrasegment; Memptr16; The word of data in memory pointed to by (DS) $0+(\mathrm{SI})$ is copied into IP.
15.
(a) $1075 \mathrm{H}: 10 \mathrm{H}$
(b) $1075 \mathrm{H}: 1000 \mathrm{H}$
(c) $1075 \mathrm{H}: 1000 \mathrm{H}$
16. ZF, CF, SF, PF, and OF.
17. $(\mathrm{SF})=0$.
18. $(\mathrm{CF})=0$ and $(\mathrm{ZF})=0$.
19.
(a) Intrasegment; short-label; if the carry flag is reset, a jump is performed by loading IP with 10 H .
(b) Intrasegment; near-label; if PF is not set, a jump is performed by loading IP with $1000_{16}$.
(c) Intersegment; memptr32; if the overflow flag is set, a jump is performed by loading the two words of the 32-bit pointer addressed by the value (DS)0 + (BX) into IP and CS, respectively.
20. 0100 H
21. (a) $1000_{16}=2^{12}=4096$ times.
(b) ;Implement the loop with the counter $=17$

MOV CX,11H
DLY: DEC CX
JNZ DLY
NXT: --- ---
(c)
;Set up a nested loop with 16-bit inner and 16-bit outer ;counters. Load these counters so that the JNZ
;instruction is encountered $2^{32}$ times.
MOV AX,0FFFFH
DLY1: MOV CX,0H
DLY2: DEC CX
JNZ DLY2
DEC AX
JNZ DLY1
NXT: ---
22. $; \mathrm{N}!=1 * 2 * 3 * 4 \ldots *(\mathrm{~N}-1) * \mathrm{~N}$
; Also note that $0!=1!=1$
MOV AL,1H ; Initial value of result
MOV CL,0H ; Start multiplying number
MOV DL,N ; Last number for multiplication
NXT: CMP CL,DL ; Skip if done
JE DONE
INC CL ; Next multiplying number
MUL CL ; Result $\leftarrow$ Result * number
JMP NXT ; Repeat
DONE: MOV [FACT],AL ; Save the result
23.

|  | MOV | CX,64H | ;Set up array counter |
| :---: | :---: | :---: | :---: |
|  | MOV | SI,0A000H | ;Set up source array pointer |
|  | MOV | DI,0B000H | ;Set up destination array ;pointer |
| GO_ON: | MOV | AX,[SI] |  |
|  | CMP | AX,[DI] | ;Compare the next element |
|  | JNE | MIS_MATCH | ;Skip on a mismatch |
|  | ADD | SI, 2 | ;Update pointers and counter |
|  | ADD | DI, 2 |  |
|  | DEC | CX |  |
|  | JNZ | GO_ON | ;Repeat for the next element |
|  | MOV | [FOUND],0H | ;If arrays are identical, save ;a zero |
|  | JMP | DONE |  |
| MIS_MATCH: DONE: | MOV | [FOUND],SI | ;Else, save the mismatch address |

## Section 6.4

24. A group of instructions that perform a special operation and can be called from any point in a program; Procedure
25. The call instruction saves the value in the instruction pointer, or in both the instruction pointer and code segment register, in addition to performing the jump operation.
26. The intersegment call provides the ability to call a subroutine in either the current code segment or a different code segment. On the other hand, the intrasegment call only allows calling of a subroutine in the current code segment.
27. IP; IP and CS.
28. 

(a) Intrasegment; Near-proc; A call is made to a subroutine by loading the immediate value 1000 H into IP.
(b) Intrasegment; Memptr16; A call is made to a subroutine by loading the word at address DS:100H into IP.
(c) Intersegment; Memptr32; A call is made to a subroutine by loading the two words of the double-word pointer located at (DS)0 $+(\mathrm{BX})+(\mathrm{SI})$ into IP and CS, respectively.
29. (a) $1075 \mathrm{H}: 1000 \mathrm{H}$
(b) $1075 \mathrm{H}: 1000 \mathrm{H}$
(c) $1000 \mathrm{H}: 0100 \mathrm{H}$
30. At the end of the subroutine a RET instruction is used to return control to the main (calling) program. It does this by popping IP from the stack in the case of an intrasegment call and both CS and IP for an intersegment call.
31.
(a) The value in the DS register is pushed onto the top of the stack, and the stack pointer is decremented by 2 .
(b) The word of data in memory location (DS) $0+(\mathrm{SI})$ is pushed onto the top of the stack, and SP is decremented by 2 ..
(c) The word at the top of the stack is popped into the DI register, and SP is incremented by 2 .
(d) The word at the top of the stack is popped into the memory location pointed to by (DS) $0+(\mathrm{BX})+(\mathrm{DI})$, and SP is incremented by 2 .
(e) The word at the top of the stack is popped into the status register, and SP is incremented by 2 .
32. ( AX ) $\leftrightarrow$ ( BX )
33. When the contents of the flags must be preserved for the instruction that follows the subroutine.
34. AGAIN: MOV AX,DX

AND AX,8000H
CMP AX,8000H ;Check bit 15 for flags
JNZ AA
MOV AX,DX
AND AX,4000H
CMP AX,4000H ;Check bit 14
JNZ BB
MOV AX,DX
AND AX,2000H
CMP AX,2000H ;Check bit 13
JNZ CC
JMP AGAIN
AA: CALL SUBA
JMP AGAIN
BB: CALL SUBB
JMP AGAIN
CC: CALL SUBC
JMP AGAIN
;Subroutine SUBA
SUBA:


## Section 6.5

35. ZF.
36. $(\mathrm{ZF})=1$ or $(\mathrm{CX})=0$.
37. Jump size $=-126$ to +129 .
38. 65,535 .
39. 

| MOV | AL,1H |  |
| :--- | :--- | :--- |
| MOV | CL,N |  |
| JCXZ | DONE | $; \mathrm{N}=0$ case |
| LOOPZ DONE | $; \mathrm{N}=1$ case |  |
| INC | CL | $;$ Restore N |

AGAIN: MUL CL
LOOP AGAIN
DONE: MOV [FACT],AL
40.

MOV AX,DATA_SEG ;Establish data segment
MOV DS,AX
MOV CX,64H
MOV SI,0A000H
MOV DI,0B000H ;Starting address of second array
GO_ON: MOV AX,[SI]
CMP AX,[DI]
JNE MISMATCH
ADD SI,2
ADD DI,2
LOOP GO_ON
MOV [FOUND],0 ;Arrays are identical
JMP DONE
;in DI

$$
\text { ;Count = } 100
$$

;Starting address of first array ;in SI
;Compare
;Exit loop if mismatch found ;Increment array address

```
MISMATCH: MOV [FOUND],SI ;Save mismatch location's address
```

    DONE: --- ---
    
## Section 6.6

41. DF.
42. ES.
43. (a) CLD

MOV ES,DS
MOVSB
(b) CLD

LODSW
(c) STD

MOV ES,DS
CMPSB
44. MOV AX,DATA_SEG ;Establish Data segment

MOV DS,AX
MOV ES,AX
CLD
MOV CX,64H
MOV SI,0A000H
MOV DI,0B000H
REPECMPSW

JZ EQUAL
MOV [FOUND],SI
JMP DONE
EQUAL: MOV [FOUND],0
DONE:
--- ---

## Advanced Problems:

45. MOV CX,64H ;Set up the counter

MOV AX,0H ;Set up the data segment
MOV DS,AX
MOV BX,A000H ;Pointer for the given array
MOV SI,B000H ;Pointer for the + ve array
MOV DI,C000H ;Pointer for the -ve array
AGAIN: MOV AX,[BX] ;Get the next source element
CMP AX,0H ;Skip if positive
JGE POSTV
NEGTV: MOV [DI],AX ;Else place in -ve array
INC DI
INC DI
JMP NXT ;Skip
POSTV: MOV [SI],AX ;Place in the +ve array

|  | INC | SI |
| :--- | :--- | :--- |
|  | NXT: |  |
| INC | SI |  |
| DEC | CX | ;Repeat for all elements |
|  | JNZ | AGAIN |
|  | HLT |  |

46. ;For the given binary number B , the BCD number's digits are given by ;D0 = R(B/10) $; \mathrm{D} 1=\mathrm{R}(\mathrm{Q}(\mathrm{B} / 10) / 10)$ $; \mathrm{D} 2=\mathrm{R}(\mathrm{Q}(\mathrm{Q}(\mathrm{B} / 10) / 10) / 10)$ ;D3 = R(Q(Q(Q(B/10)/10)/10)/10) ;where R and Q stand for the remainder and the quotient.

MOV SI,0
MOV CH,4
MOV BX,10
MOV AX,DX
NEXTDIGIT: MOV DX,0
DIV BX
CMP DX,9 ;Invalid if > 9
JG INVALID
MOV CL,12 ;Position as most significant digit
SHL DX,CL
OR SI,DX
DEC CH ;Repeat for all four digits
JZ DONE
MOV CL,4 ;Prepare for next digit
SHR SI,CL
JMP NEXTDIGIT
INVALID: MOV DX,FFFFH ;Invalid code
JMP DONE1
DONE: MOV DX,SI
DONE1: --- ---
47. ;Assume that all arrays are in the same data segment

| MOV | AX,DATASEG | ;Set up data segment |
| :--- | :--- | :--- |
| MOV | DS,AX |  |
| MOV | ES,AX |  |
| MOV | SI,OFFSET_ARRAYA | ;Set up pointer to array A |
| MOV | DI,OFFSET_ARRAYB | ;Set up pointer to array B |
| MOV | CX,62H | ;Initialize A(I-2) and B(1) |
| MOV | AX,[SI] |  |
| MOV | ARRAYC,AX |  |
| MOV | [DI],AX |  |
| ADD | SI,2 |  |
| ADD | DI,2 | ;Initialize A(I-1) and B(2) |
| MOV | AX,[SI] |  |
| MOV | ARRAYC+1,AX |  |
| MOV | $[D I], A X ~$ |  |

```
    ADD SI,2
    ADD DI,2
    MOV AX,[SI]
    MOV ARRAYC+2,AX
    ADD SI,2
    MOV AX,[SI]
    MOV ARRAYC+3,AX
    ADD SI,2
    MOV AX,[SI]
    MOV ARRAYC+4,AX
    ADD SI,2
    NEXT: CALL SORT
    MOV AX,ARRAYC+2
    MOV [DI],AX
    ADD DI,2
    MOV AX,ARRAYC+1
    MOV ARRAYC,AX
    MOV AX,ARRAYC+2
    MOV ARRAYC+1,AX
    MOV AX,ARRAYC+3
    MOV ARRAY+2,AX
    MOV AX,ARRAYC+4
    MOV ARRAYC+3,AX
    MOV AX,[SI]
    MOV ARRAY+4,AX
    ADD SI,2
    LOOP NEXT
    SUB SI,4
    MOV AX,[SI]
    MOV [DI],AX
    ADD SI,2
    ADD DI,2
    MOV AX,[SI]
    MOV [DI],AX
    DONE:
;SORT subroutine
    SORT: PUSHF
        PUSH AX
    PUSH BX
    PUSH DX
    MOV SI,OFFSET_ARRAYC
    MOV BX,OFFSET_ARRAYC+4
AA: MOV DI,SI
    ADD DI,02H
BB: MOV AX,[SI]
    CMP AX,[DI]
```

;Initialize A(I)
;Initialize A(I+1)
;Initialize A(I+2)
;Sort the 5 element array
;Save the median
;Shift the old elements
;Add the new element
;Repeat
;The last two elements of array B
;Save registers and flags

|  | JLE | CC |  |
| :--- | :--- | :--- | :--- |
|  | MOV | DX,[DI] |  |
| MOV | $[$ SI],DX |  |  |
|  | CC: | MOV | $[$ DI],AX |
|  | INC | DI |  |
|  | INC | DI |  |
| CMP | DI,BX |  |  |
|  | JBE | BB |  |
| INC | SI |  |  |
|  | INC | SI |  |
|  | CMP | SI,BX |  |
|  | JB | AA |  |
|  | POP | DX |  |
| POP | BX |  |  |
|  | POP | AX |  |
| POPF |  |  |  |
| RET |  |  |  |

48. ;For the decimal number $=$ D3D2D1D0,
;the binary number $=10(10(10(0+\mathrm{D} 3)+\mathrm{D} 2)+\mathrm{D} 1)+\mathrm{D} 0$

| MOV | BX,0 | ;Result $=0$ |
| :--- | :--- | :--- |
| MOV | SI,0AH | ;Multiplier $=10$ |

MOV CH,4 ;Number of digits $=4$
MOV CL,4 ;Rotate counter $=4$
MOV DI,DX
NXTDIGIT: MOV AX,DI ;Get the decimal number
ROL AX,CL ;Rotate to extract the digit
MOV DI,AX ;Save the rotated decimal number
AND AX,0FH ;Extract the digit
ADD AX,BX ;Add to the last result
DEC CH
JZ DONE ;Skip if this is the last digit
MUL SI ;Multiply by 10
MOV BX,AX ;and save
JMP NXTDIGIT ;Repeat for the next digit
DONE: MOV DX,AX ;Result = (AX)
49. ;Assume that the offset of $\mathrm{A}[\mathrm{I}]$ is AI1ADDR
;and the offset of $\mathrm{B}[I]$ is BI1ADDR
MOV AX,DATA_SEG ;Initialize data segment
MOV DS,AX
MOV CX,62H
MOV SI,AI1ADDR ;Source array pointer
MOV DI,BI1ADDR ;Destination array pointer
MOV AX,[SI]
MOV [DI],AX
MORE: MOV AX,[SI]
ADD SI,2
; $\mathrm{B}[1]=\mathrm{A}[1]$
;Store A[I] into AX
;Increment pointer

|  | MOV | BX,[SI] | ;Store A[I+1] into BX |
| :---: | :---: | :---: | :---: |
|  | ADD | SI, 2 |  |
|  | MOV | CX,[SI] | ;Store A[I+2] into CX |
|  | ADD | SI, 2 |  |
|  | CALL | ARITH | ;Call arithmetic subroutine |
|  | MOV | [DI],AX |  |
|  | SUB | SI, 4 |  |
|  | ADD | DI,2 |  |
|  | LOOP | MORE | ;Loop back for next element |
|  | ADD | SI, 4 |  |
| DONE: | MOV | AX,[SI] | ; $\mathrm{B}[100]=\mathrm{A}[100]$ |
|  | MOV | [DI],AX |  |
|  | HLT |  |  |
| ;Subroutin | for arithm | metic |  |
| ; (AX) $\leftarrow$ | AX) - 5( | (BX) +9 ( |  |
| ARITH: | PUSHF |  | ;Save flags and registers in stack |
|  | PUSH | BX |  |
|  | PUSH |  |  |
|  | PUSH | DX |  |
|  | PUSH |  |  |
|  | MOV | DX,CX | ; $(\mathrm{DX}) \leftarrow(\mathrm{CX})$ |
|  | MOV | DI,CX |  |
|  | MOV | CL, 3 |  |
|  | SAL | DX,CL |  |
|  | ADD | DX,DI |  |
|  | MOV | CL, 2 | $;(\mathrm{AX}) \leftarrow 5(\mathrm{BX})$ |
|  | MOV | DI,BX |  |
|  | SAL | BX,CL |  |
|  | ADD | BX,DI |  |
|  | SUB | AX,BX | $;(\mathrm{AX}) \leftarrow[(\mathrm{AX})-5(\mathrm{BX})+9(\mathrm{CX})] / 4$ |
|  | ADD | AX,DX |  |
|  | SAR | AX,CL |  |
|  | POP | DI | ;Restore flags and registers |
|  | POP | DX |  |
|  | POP | CX |  |
|  | POP | BX |  |
|  | POPF |  |  |
|  | RET |  | ;Return |

50. ;Set up ASCII offset in SI, EBCDIC offset in DI
;and translation table offset in BX

| MOV | SI,OFFSET DATASEG1_ASCII_CHAR |  |
| :--- | :---: | :--- |
| MOV | DI,OFFSET DATASEG2_EBCDIC_CHAR |  |
| MOV | BX,OFFSET DATASEG3_ASCII_TO_EBCDIC |  |
| CLD | ;Select autoincrement mode |  |
| MOV | CL,64H | ;Byte count |

MOV AX,DATASEG1
MOV DS,AX
MOV AX,DATASEG2
MOV ES,AX

NEXTBYTE:
LODSB
MOV DX,DATASEG3
MOV DS,DX
XLAT
STOSB
MOV DX,DATASEG1
MOV DS,AX
LOOP NEXTBYTE
DONE: --- ---
;ASCII segment
;EBCDIC segment
;Get the ASCII
;Translation table segment
;Translate
;Save EBCDIC
;ASCII segment for next ASCII
;element

## Chapter 7

## Section 7.1

1. Macroassembler
2. Assembly language statements and directive statements
3. Assembly language instructions tell the MPU what operations to perform.
4. Directives give the macroassembler directions about how to assemble the source program.
5. Label, opcode, operand(s), and comment(s)
6. Opcode
7. 

(a) Fields must be separated by at least one blank space.
(b) Statements that do not have a label must have at least one blank space before the opcode.
8. A label gives a symbolic name to an assembly language statement that can be referenced by other instructions.
9. 31
10. Identifies the operation that must be performed.
11. Operands tell where the data to be processed resides and how it is to be accessed.
12. The source operand is immediate data FFH and the destination operand is the CL register.
13. Document what is done by the instruction or a group of instructions; the assembler ignores comments.
14.
(a) A directive statement may have more than two operands whereas an assembly language statement always has two or less operands.
(b) There is no machine code generated for directive statements. There is always machine code generated for an assembly language statement.
15. MOV AX,[01111111111011000B]; MOV AX,[7FD8H].
16. JMP 11001B; JMP 19H.
17. MOV AX, 0 .

## Section 7.2

18. Directive.
19. Data directives, conditional directives, macro directives, listing directives.
20. Define values for constants, variables, and labels.
21. The symbol SRC_BLOCK is given 0100 H as its value, and symbol DEST_BLOCK is given 0120 H as its value.
22. The value assigned by an EQU directive cannot be changed, whereas a value assigned with the $=$ directive can be changed later in the program.
23. The variable SEG_ADDR is allocated word-size memory and is assigned the value $1234_{16}$.
24. A block of 128 bytes of memory is allocated to the variable BLOCK_1 and these storage locations are left uninitialized.
25. INIT_COUNT DW 0F000H
26. SOURCE_BLOCK DW 16 DUP(?)
27. 

SOURCE_BLOCK DW $0000 \mathrm{H}, 1000 \mathrm{H}, 2000 \mathrm{H}, 3000 \mathrm{H}, 4000 \mathrm{H}, 5000 \mathrm{H}$, $6000 \mathrm{H}, 7000 \mathrm{H}, 8000 \mathrm{H}, 9000 \mathrm{H}, \mathrm{A} 000 \mathrm{H}, \mathrm{B} 000 \mathrm{H}, \mathrm{C} 000 \mathrm{H}, \mathrm{D} 000 \mathrm{H}, \mathrm{E} 000 \mathrm{H}, \mathrm{F} 000 \mathrm{H}$
28. This directive statement defines data segment DATA_SEG so that it is byte aligned in memory and located at an address above all other segments in memory.
29.

DATA_SEG SEGMENT WORD COMMON 'DATA'

DATA_SEG ENDS
30. Module.
31. A section of program that performs a specific function and can be called for execution from other modules.
32.

PUBLIC BLOCK
BLOCK PROC FAR

RET
BLOCK ENDP
33. An ORG statement specifies where the machine code generated by the assembler for subsequent instructions will reside in memory.
34. ORG 1000 H
35.

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## Section 7.3

36. Menu driven text editor
37. Move, copy, delete, find, and find and replace.
38. File, Edit, Search, and Options.
39. Use Save As operations to save the file under the filenames BLOCK.ASM and BLOCK.BAK. When the file BLOCK.ASM is edited at a later time, an original copy will be preserved during the edit process in the file BLOCK.BAK.

## Section 7.4

40. Source module
41. 

Object module: machine language version of the source program.
Source listing: listing that includes memory address, machine code, source statements, and a symbol table.
42. Looking at Fig. 7.20, this error is in the equal to directive statement that assigns the value 16 to N and the error is that the $=$ sign is left out.
43. In Fig. 7.20, this error is in the comment and the cause is a missing "';" at the start of the statement.
44. No, the output of the assembler is not executable by the 8088 in the PC: it must first be processed with the LINK program to form a run module.
45.
(a) Since separate programmers can work on the individual modules, the complete program can be written in a shorter period of time.
(b) Because of the smaller size of modules, they can be edited and assembled in less time.
(c) It is easier to reuse old software.
46. Object modules
47.

Run module: executable machine code version of the source program.
Link map: table showing the start address, stop address, and length of each memory segment employed by the program that was linked.

## 48.

Source module file = BLOCK.ASM
Object module file = BLOCK.OBJ
Source listing file $=$ BLOCK.LST
49. Object Modules[.OBJ]:A:MAIN.OBJ+A:SUB1.OBJ+A:SUB2.OBJ

## Section 7.5

50. C:LDOS>DEBUG B:LAB.EXE

## CHAPTER 8

## Section 8.1

1. HMOS.
2. 29,000 .
3. 17 .
4. 34 .
5. 1 Mbyte.
6. 64 Kbytes.

## Section 8.2

7. The logic level of input MN/MX---- determines the mode. Logic 1 puts the MPU in minimum mode, and logic 0 puts it in maximum mode.
8. In the minimum-mode, the 8088 directly produces the control signals for interfacing to memory and I/O devices. In the maximum-mode these signals are encoded in the status lines and need to be decoded externally. Additionally, the maximum-mode 8088 produces signals for supporting multiprocessing systems.
9. WR----, LOCK----.
10. Output.
11. SSO----.
12. Maximum mode.

## Section 8.3

13. 20-bit, 8 -bit; 20-bit, 16-bit.
14. Multiplexed.
15. $\mathrm{A}_{0}, \mathrm{D}_{7}$.
16. Stack.
17. BHE----.
18. Whether a memory or I/O transfer is taking place over the bus.
19. WR----
20. INTA----
21. HOLD, HLDA.
22. $\mathrm{AD}_{0}$ through $\mathrm{AD}_{7}, \mathrm{~A}_{8}$ through $\mathrm{A}_{15}, \mathrm{~A}_{16} / \mathrm{S}_{3}$ through $\mathrm{A}_{19} / \mathrm{S}_{6}$, SSO----, IO/M----, DT/R---- RD----, WR---- DEN---- and INTR.

## Section 8.4

23. HOLD, HLDA, WR----, IO/M----, DT/R----, DEN----, ALE, and INTA---- in minimum mode are RQ----/GT----1,0, LOCK----, S----2, S----1, S----0, QS ${ }_{0}$, and QS $_{1}$, respectively, in the maximum mode.
24. S----2 through S----0.
25. MRDC----, MWTC-----, AMWC----, IORC----, IOWC----, AIORC----, INTA----, MCE/PDEN, DEN, DT/R----, and ALE.
26. The LOCK---- signal is used to implement an arbitration protocol that permits multiple processors to reside on the 8088's system bus.
27. $S---{ }_{2} S---{ }_{1} S----0=101_{2}$.
28. MRDC----.
29. $\mathrm{QS}_{1} \mathrm{QS}_{0}=10_{2}$.
30. RQ----/GT----1,0.

## Section 8.5

31. +4.5 V to +5.5 V .
32. +0.45 V .
33. +2.0 V .
34. 2.5 mA .

## Section 8.6

35. 5 MHz and 8 MHz .
36. 24 MHz .
37. CLK, PCLK, and OSC; $10 \mathrm{MHz}, 5 \mathrm{MHz}$, and 30 MHz .
38. $\mathrm{V}_{\mathrm{H} \min }=3.9 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{H} \max }=\mathrm{V}_{\mathrm{cc}}+1 \mathrm{~V}, \mathrm{~V}_{\mathrm{L} \min }=-0.5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{Lmax}}=0.6 \mathrm{~V}$.

## Section 8.7

39. 4; $\mathrm{T}_{1}, \mathrm{~T}_{2}, \mathrm{~T}_{3}$, and $\mathrm{T}_{4}$.
40. 800 ns
41. An idle state is a period of no bus activity that occurs because the prefetch queue is full and the instruction currently being executed does not require bus activity.
42. A wait state is a clock cycle inserted between the $T_{3}$ and $T_{4}$ states of a bus cycle to extend its duration to accommodate slow devices in the system.
43. 600 ns .

## Section 8.8

44. $1 \mathrm{M} \times 8 ; 512 \mathrm{~K} \times 16$.
45. Address $\mathrm{B} 0003_{16}$ is applied over the lines $\mathrm{A}_{0}$ through $\mathrm{A}_{19}$ of the address bus, and a byte of data is fetched over data bus lines $\mathrm{D}_{0}$ through $\mathrm{D}_{7}$. Only one bus cycle is required to read a byte from memory. Control signals in minimum mode at the time of the read are $\mathrm{A}_{0}=1$, WR---- $=1$, RD---- $=0, \mathrm{IO} / \mathrm{M}----=0$, DT/R---- $=0$, and DEN---- $=0$.
46. Two bus cycles must take place to write the word of data to memory. During the first bus cycle, the least significant byte of the word is written to the byte storage location at address $\mathrm{A} 0000_{16}$. Next the 8088 automatically increments the address so that it points to the byte storage location $\mathrm{A} 0001_{16}$. The most significant byte of the word is written into this storage location with a second write bus cycle. During both bus cycles, address information is applied to the memory subsystem over address lines $\mathrm{A}_{0}$ through $\mathrm{A}_{19}$ and data are transferred over data bus lines $\mathrm{D}_{0}$ through $\mathrm{D}_{7}$. The minimum mode control signals during the write are: WR---- = 0, DT/R---- = 1 , and DEN---- $=0$.
47. High bank, BHE----.
48. $\mathrm{D}_{0}$ through $\mathrm{D}_{7} ; \mathrm{A}_{0}$.
49. BHE---- $=0, \mathrm{~A}_{0}=0$, WR---- $=0, \mathrm{M} / \mathrm{IO}----=1$, DT/R---- $=1$, and DEN---- $=0$.
50. $\mathrm{BHE}---=0, \mathrm{~A}_{0}=1$, WR---- $=0, \mathrm{M} / \mathrm{IO}---=1$, DT/R---- $=1$, DEN $---=0 ; \mathrm{D}_{8}$ through $\mathrm{D}_{15}$.

## Section 8.9

51. $\mathrm{S}_{4} \mathrm{~S}_{3}=10$.
52. $\mathrm{S}_{4} \mathrm{~S}_{3}=01$.

Section 8.10
53. IO/M----
54. SSO----; BHE----.
55. $\mathrm{S}----{ }_{2} \mathrm{~S}---{ }_{1} \mathrm{~S}----0=100$; MRDC----
56. S----2 $S---{ }_{1} S----0=110$, MWTC---- and AMWC----
57. $\mathrm{S}_{4} \mathrm{~S}_{3}=01$ and $\mathrm{S}---{ }_{2} \mathrm{~S}---{ }_{1} \mathrm{~S}---{ }_{0}=110$; MWTC ---- and AMWC----

## Section 8.11

58. $4 ; 400 \mathrm{~ns}$.
59. Address is output on $A_{0}$ through $A_{19}$, ALE pulse is output, and IO/M----, DEN----, and DT/R---- are set to the appropriate logic levels.
60. During $\mathrm{T}_{1}$ the 8088 outputs address B0010H on the bus and asserts ALE. The address for the memory must be latched external to the 8088 using ALE to gate the latch device. The 8088 also asserts the control signals: IO/M---- $=0$ and DT/R---- $=1$ at this time. During $\mathrm{T}_{2}$ WR---- is asserted (logic 0) and then the 8088 puts the byte of data onto the data bus. This data remains valid until the end of $\mathrm{T}_{4}$ and should be written into memory with the active low level of WR---- during the $\mathrm{T}_{3}$ state terminating the write operation as WR---- goes inactive in the $\mathrm{T}_{4}$ state.
61. WR----, DT/R----.
62. ALE.

## Section 8.12

63. The 8288 bus controller produces the appropriately timed command and control signals needed to coordinate transfers over the data bus.
The address bus latch is used to latch and buffer the address bits.
The address decoder decodes the higher order address bits to produce chip-enable signals.
The bank write control logic determines which memory bank is selected during a write bus cycle.
The bank read control logic determines which memory bank is selected during a read bus cycle.
The data bus transceiver/buffer controls the direction of data transfers between the MPU and memory subsystem and supplies buffering for the data bus lines.
64. $S---{ }_{2} S---{ }_{1} S---{ }_{0}=110, A_{0}$ BHE---- $=00$, MWTC---- and AMWC----
65. D-type latches.
66. BHEL----=0, MRDC----=0,MWRC $---=1, \mathrm{~A}_{0 L}=0$.
67. 


(a) Byte read $1 \quad 0 \quad 1$
$1 \quad 1$
1
0
1
0 from address
01234H
$\begin{array}{lllllllll}\text { (b) Byte write } & 1 & 1 & 0 & 1 & 0 & 1 & 0 & 1\end{array}$ to address
01235 H
$\begin{array}{cllllllll}\text { (c) Word read } & 0 & 0 & 1 & 1 & 0 & 0 & 1 & 0\end{array}$ from address
01234H
$\begin{array}{lllllllll}\text { (d) Word write } & 0 & 0 & 1 & 1 & 0 & 1 & 0 & 0\end{array}$ to address
01234H
68. Eight bidirectional buffers.
69. DEN---- = 0, DT/R---- = 0
70.

71. Three address lines decode to generate eight chip selects. Therefore, three of them need not be used.
72. 74F139
73. $Y_{5}=0$
74.

MEMR---- MEMW---- RD---- WR---- IO/M----

| 0 | 1 | 0 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- |
| 1 | 0 | 1 | 0 | 0 |
| $\mathrm{Y}_{2}$ | $\mathrm{Y}_{4}$ | C | B | A |

of the 74 F 138


## Section 8.13

75. Programmable logic array.
76. Number of inputs, number of outputs, and number of product terms.
77. Fuse links
78. Programmable array logic; In a PAL only the AND array is programmable.
79. 


$\mathbf{8 0 . 1 0}$ dedicated inputs, 2 dedicated outputs, 6 programmable I/Os, and 64 product terms.
81. 20 inputs; 8 outputs.
82. The 16R8 has registered outputs whereas the 16L8 has latched outputs.
83.


## Section 8.14

84. Isolated I/O and memory-mapped I/O.
85. Isolated I/O.
86. Memory-mapped I/O.
87. Isolated I/O

## Section 8.15

88. Address lines $\mathrm{A}_{0}$ through $\mathrm{A}_{15}$ carry the address of the I/O port to be accessed; address lines $\mathrm{A}_{16}$ through $\mathrm{A}_{19}$ are held at the 0 logic level. Data bus lines $\mathrm{D}_{0}$ through $\mathrm{D}_{7}$ carry the data that are transferred between the MPU and I/O port.
89. IO/M----.
90. In the 8086 's $\mathrm{I} / \mathrm{O}$ interface, the 8 -bit data bus is replaced by a 16 -bit data bus $\mathrm{AD}_{0}$ through $\mathrm{AD}_{15}$; control signal $\mathrm{IO} / \mathrm{M}---$ is replaced by $\mathrm{M} / \mathrm{IO}----$; and status signal $\mathrm{SSO}---$ is replaced by BHE----.
91. $\mathrm{M} / \mathrm{IO}---$ - is the complement of IO/M----.
92. 8288. 
1. The bus controller decodes I/O bus commands to produce the input/output and bus control signals for the I/O interface. The I/O interface circuitry provides for addressing of I/O devices as well as the path for data transfer between the MPU and the addressed I/O device.
2. $\mathrm{S}_{2}---\mathrm{S}_{1}----\mathrm{S}_{0}---=001$.
3. IORC---- = 1, IOWC---- = 0, AIOWC---- = 0 .

## Section 8.16

96. 16 bits.
97. $0000_{16}$ through FFFF $_{16}$.
98. 32 K word-wide $\mathrm{I} / \mathrm{O}$ ports.
99. $\mathrm{A}_{0}=0$ and $\mathrm{BHE}---=1 ; \mathrm{A}_{0}=0$ and BHE- $--=0$.
100. 2; 1 .

## Section 8.17

101. Execution of this input instruction causes accumulator AX to be loaded with the contents of the word-wide input port at address 1AH.
102. MOV DX, 1AH

IN DX, AX
103. Execution of this output instruction causes the value in the lower byte of the accumulator (AL) to be loaded into the byte wide output port at address 2AH.
104. MOV AL, 0 FH ; Output 0 fH to port at 1000 H

MOV DX, 1000H
OUT DX, AL
105. MOV DX,0A000H ;Input data from port at A000H

IN AL,DX
MOV BL,AL ;Save it in BL
MOV DX,0B000H ;Input data from port at B000H
IN AL,DX
ADD BL,AL ;Add the two pieces of data
MOV [IO_SUM],BL ;Save result in the memory location
106. IN AL, B0H ;Read the input port

AND AL,01H ;Check the LSB
SHR AL, 1
JC ACTIVE_INPUT ;Branch to ACTIVE_INPUT if the LSB = 1

## Section 8.18

107. IO/M---- and ALE in $T_{1}$, and RD---- and DEN---- in $T_{2}$.
108. Address is output in $T_{1}$; Data are read (input) in $T_{3}$.
109. With zero wait states, the 8088 needs to perform two output bus cycles. They require 8 T -states, which at 5 MHz equals $1.6 \mu \mathrm{~s}$.
110. With two wait states, the 8086 requires 6 T-states for an output bus cycle. At 10

MHz clock, it therefore takes 600 ns for the output operation.
111. To write a word of data to an odd address, the 8086 requires two bus cycles. Since each bus cycle has two wait states, it takes 12 T -states to perform the output operation.
With a $10-\mathrm{MHz}$ clock, the output operation takes 1200 ns .

## CHAPTER 9

## Section 9.1

1. Program-storage memory; data-storage memory.
2. Basic input/output system.
3. Firmware.
4. Yes.

## Section 9.2

5. When the power supply for the memory device is turned off, its data contents are not lost.
6. Programmable read only memory; erasable programmable read only memory.
7. Ultraviolet light.
8. $1,048,576$ bits $(1 \mathrm{MB}) ; 131,072 \times 8$ bits $=128$ Kbytes.
9. We are assuming that external decode logic has already produced active signals for CE---- and OE----. Next the address is applied to the A inputs of the EPROM and decoded within the device to select the storage location to be accessed. After a delay equal to $\mathrm{t}_{\mathrm{ACC}}$, the data at this storage location are available at the D outputs.
10. 27C512.
11. The access time of the 27 C 64 is 250 ns and that of the $27 \mathrm{C} 64-1$ is 150 ns . That is, the $27 \mathrm{C} 64-1$ is a faster device.
12. $6 \mathrm{~V}, 12.5 \mathrm{~V}$.
13. 1 ms .

## Section 9.3

14. Static random access read/write memory and dynamic random access read/write memory.
15. Volatile.
16. Maintain the power supply and refresh the data periodically.
17. $32 \mathrm{~K} \times 32$ bits ( $1 \mathrm{MB} \mathrm{)}$.
18. $\mathrm{t}_{\mathrm{WC}}=100 \mathrm{~ns}, \mathrm{t}_{\mathrm{CW} 1}=80 \mathrm{~ns}, \mathrm{t}_{\mathrm{CW} 2}=80 \mathrm{~ns}, \mathrm{t}_{\mathrm{WP}}=60 \mathrm{~ns}, \mathrm{t}_{\mathrm{DW}}=40 \mathrm{~ns}$, and $\mathrm{t}_{\mathrm{WR}}=5 \mathrm{~ns}$.
19. Higher density and lower power.
20. Row address and column address.
21. 


22. Cost and board space required for the additional circuitry needed to perform row and column address multiplexing and periodic refreshing of the memory cells.

## Section 9.4

23. Parity-checker/generator circuit.
24. Odd parity; even parity.
25. $\Sigma_{\text {EVEN }}=0 ; \Sigma_{\text {ODD }}=1$.
26. $\Sigma_{\text {EVEN }}$ becomes the parity bit ( $\mathrm{D}_{\mathrm{PB}}$ ) and $\Sigma_{\text {ODD }}$ becomes the parity error (PE----).
27. 



## Section 9.5

28. The cells in a FLASH memory are electrically erasable.
29. The storage array in the bulk-erase device is a single block, whereas the memory array in both the boot block and FlashFile is organized as multiple independently erasable blocks.
30. The blocks of a boot block device are asymmetrical in size and those of the FlashFile are symmetrical.
31. Bulk erase.
32. $\mathrm{V}_{\mathrm{cc}}=5 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{pp}}=12 \mathrm{~V}$.
33. 28F002 and 28F004.
34. $\mathrm{V}_{\mathrm{cc}}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{pp}}=5 \mathrm{~V}$ or 12 V .
35. 

| Type | Quantity | Sizes |
| :--- | :--- | :--- |
| Boot block | 1 | 16 Kbyte |
| Parameter block | 2 | 8 Kbyte |
| Main block | 4 | (1) 96Kbyte, (3) 128Kbyte |

36. 28 F 008 and 28F016SA.
37. Logic 0 at the RY/BY---- output signals that the on-chip write state machine is busy performing an operation. Logic 1 means that it is ready to start another operation.

## Section 9.6

38. Insert wait states into the bus cycles of the 8088/8086.
39. READY.
40. Yes, two wait states.
41. Seven.

## Section 9.7

42. 


42. (Continued)

43. Byte addresses 00000 H through 03 FFFH ; word addresses 00000 H through 03 FFEH .
44. 128 .
45. 6;3.
46.

46. (Continued)


## CHAPTER 10

## Section 10.1

1. Keyboard interface, display interface, and parallel printer interface.
2. Parallel input/output ports, interval timers, direct memory access interface.

## Section 10.2

3. $\mathrm{A}_{15 \mathrm{~L}} \mathrm{~A}_{14 \mathrm{~L}} \ldots \ldots . \mathrm{A}_{4 \mathrm{~L}} \mathrm{~A}_{3 \mathrm{~L}} \mathrm{~A}_{2 \mathrm{~L}} \mathrm{~A}_{1 \mathrm{~L}} \mathrm{~A}_{0 \mathrm{~L}}=1 \mathrm{X} . \ldots . . \mathrm{X} 1110_{2}=800 \mathrm{E}_{16}$ with $\mathrm{X}=0$.
4. $\mathrm{G}_{1}=\mathrm{A}_{15 \mathrm{~L}}=1$, G----2B$=\mathrm{A}_{0 \mathrm{~L}}=0$, G----2A$=(I O / \mathrm{M}----)---=0$, and CBA $=\mathrm{A}_{3 \mathrm{~L}} \mathrm{~A}_{2 \mathrm{~L}} \mathrm{~A}_{1 \mathrm{~L}}$
$=101$. This make $P_{5}$ equal to 0 and Port 5 is selected.
5. Sets all outputs at port $2\left(\mathrm{O}_{16}-\mathrm{O}_{23}\right)$ to logic 1 .
6. MOV DX, 8000 H ;Write low byte to port 8000 H

MOV AX, [DATA]
OUT DX, AL
MOV DX, 8002H ;Write high byte to port 8002H
MOV AL, AH
OUT DX, AL

## Section 10.3

7. Port 4.
8. The value at Port 0 is read into AL; then the upper four bits are masked off; and finally the masked value is copied into memory location LOW_NIBBLE.
9. MOV AX,0A000H
;Set up the segment to start at A0000H
MOV DS, AX
MOV DX,8002H
IN AL, DX
MOV [0000H],AL
MOV DX,8004H
;Input from port 2
IN AL, DX
MOV [0001H],AL
;Save the input at A0001H
10. POLL_O63: MOV DX,800EH ;Input from port 7

IN AL,DX
SHL AL, $1 \quad$;Place the MSB in the CF
JC POLL_O63

## Section 10.4

11. Handshaking.
12. STB----, Input, Signals that a byte of data is available on $D_{0}-D_{7}$.

BUSY, Output, Signals the MPU that the printer is busy and is not yet ready to receive another character data.
13. 74F373 octal latch.
14. First, the address is clocked into the address latch. Address bits $\mathrm{A}_{3 \mathrm{~L}} \mathrm{~A}_{2 \mathrm{~L}} \mathrm{~A}_{1 \mathrm{~L}}=000$, $\mathrm{A}_{0 \mathrm{~L}}=0$, and $\mathrm{A}_{15 \mathrm{~L}}=1$ enable the decoder and switch the $\mathrm{P}_{0}$ output to 0 . This output activates one input of the gate that drives the CLK input of the Port 0 latch. Later in the bus cycle, the byte of data is output on data bus lines $\mathrm{D}_{0}$ through $\mathrm{D}_{7}$. DT/R---- is logic 1 and DEN---- equals 0 . Therefore, the transceiver is set for transmit (output) mode of operation and the byte of data is passed to the data inputs of all ports. Finally, the write pulse at WR---- supplies the second input of the gate for the CLK input of Port 0 . Since both inputs of the gate are now logic 0 , the output switches to 0 . As WR---- returns to logic 1, the positive clock edge is presented to the latch, which enables the data to be latched and made available at outputs $\mathrm{O}_{0}$ through $\mathrm{O}_{7}$ of Port 0 .
15. PUSH DX ;Save all registers to be used

PUSH AX
PUSH CX
PUSH SI
PUSH BX

| $\cdot$ |  |
| :--- | :--- |
| $\cdot$ | ;Program of Example 10.6 starts here |
| $\cdot$ |  |
| POP | BX |
| POP | SI |
| POP | CRestoram of Example 10.6 ends here |
| POP | AX |
| POP | DX |
| RET |  |

## Section 10.5

16. Parallel I/O.
17. 24. 
1. $\mathrm{PA}_{0}-\mathrm{PA}_{7}, \mathrm{~PB}_{0}-\mathrm{PB}_{7}, \mathrm{PC}_{0}-\mathrm{PC}_{7}$.
2. Mode 0 selects simple I/O operation. This means that the lines of the port can be configured as level-sensitive inputs or latched outputs. Port A and port B can be configured as 8-bit input or output ports, and port C can be configured for operation as two independent 4-bit input or output ports.

Mode 1 operation represents what is known as strobed I/O. In this mode, ports A and B are configured as two independent byte-wide I/O ports, each of which has a 4-bit control port associated with it. The control ports are formed from port C's lower and upper nibbles, respectively. When configured in this way, data applied to an input port must be strobed in with a signal produced in external hardware. An output port is provided with handshake signals that indicate when new data are available at its outputs and when an external device has read these values.

Mode 2 represents strobed bidirectional I/O. The key difference is that now the port works as either input or output and control signals are provided for both functions. Only port A can be configured to work in this way.
20. Port $B$ can be configured as an input or output port in mode 0 or mode 1 .
21. $\mathrm{D}_{0}=1$ Lower 4 lines of port C are inputs
$D_{1}=1$ Port B lines are inputs
$\mathrm{D}_{2}=0$ Mode 0 operation for both port B and the lower 4 lines of port C
$D_{3}=1$ Upper 4 lines of port $C$ are inputs
$\mathrm{D}_{4}=1$ Port A lines are inputs
$\mathrm{D}_{6} \mathrm{D}_{5}=00$ Mode 0 operation for both port A and the upper 4 lines of port C
$\mathrm{D}_{7}=1$ Mode being set
22. Port $\mathrm{A}=$ Mode 1 output; Port $\mathrm{B}=$ Mode 1 output.
23. Control word bits $=\mathrm{D}_{7} \mathrm{D}_{6} \mathrm{D}_{5} \mathrm{D}_{4} \mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}=10010010_{2}=92 \mathrm{H}$
24. $\mathrm{D}_{0}=0$ Don't care bit
$D_{1}=1$ Port B lines are inputs
$\mathrm{D}_{2}=1$ Mode 1 operation for both port B and the lower 4 lines of port C
$\mathrm{D}_{3}=0$ Don't care bit
$\mathrm{D}_{4}=1$ Port A lines are inputs
$\mathrm{D}_{6} \mathrm{D}_{5}=01$ Mode 1 operation for both port A and the upper 4 lines of port C
$\mathrm{D}_{7}=1$ Mode being set
This gives
$\mathrm{D}_{7}-\mathrm{D}_{0}=10110110_{2}=\mathrm{B} 6 \mathrm{H}$
25. MOV DX, 1000H ;Load the control register with 92H

MOV AL,92H
OUT DX,AL
26. MOV AX, 0 H ;Set up the data segment

MOV DS, AX
MOV AL, 92H ;Write the control byte
MOV [100H], AL
27. To enable INTR $_{B}$, the INTE B bit must be set to 1 . This is done with a bit set/reset operation that sets bit $\mathrm{PC}_{4}$ to 1 . This command is

$$
\mathrm{D}_{7}-\mathrm{D}_{0}=0 \mathrm{XXX} 1001
$$

28. $\mathrm{PC}_{1} ; \operatorname{logic} 1$.
29. MOV AL,03H ;Load the control register with 03 H

MOV DX,100H
OUT DX,AL

## Section 10.6

30. $3 \mathrm{E}_{16}=00111110_{2}$ generates $\mathrm{A}_{0}=0$ to enable $\mathrm{G}----2 \mathrm{~B}$;
$\mathrm{A}_{5} \mathrm{~A}_{4} \mathrm{~A}_{3}=111_{2}$ to generate $\mathrm{O}_{7}=0$ and to enable PPI $14 ; \mathrm{A}_{2} \mathrm{~A}_{1}=11$ to select the control register. Therefore, $98_{16}$ is written to the control register in PPI 14.
31. The value at the inputs of port $A$ of PPI 2 is read into AL.
32. Port A address $=\mathrm{XX} 001000_{2}$

Port B address $=\mathrm{XX} 001010_{2}$
Port C address $=\mathrm{XX} 001100_{2}$
33. IN AL, $08 \mathrm{H} \quad$; Read port A

MOV BL,AL ; Save in BL
IN AL,0AH ; Read port B
ADD AL, BL ; Add the two numbers

OUT 0CH,AL ; Output to port C

## Section 10.7

34. Memory-mapped I/O
i) 20 address lines for I/O addresses in the 1M memory address space.
ii) Memory read/write control signals are used to communicate.
iii) Memory addressing instructions such as MOV are used to transfer data. A number of addressing modes become available to address the I/O devices. Data can be transferred between the device and almost any register of the MPU. Arithmetic and logical operations can be done directly with the data on the device.
iv) In general slower I/O operation.

Isolated I/O
16 address lines for I/O addresses in 64 K I/O address space.
I/O read/write control signals are used to communicate.
IN and OUT instructions must be used to transfer data. Data can be transferred only between the device and the accumulator register.
35. To access port B on PPI 4
$\mathrm{A}_{0}=0, \mathrm{~A}_{2} \mathrm{~A}_{1}=01$, and $\mathrm{A}_{5} \mathrm{~A}_{4} \mathrm{~A}_{3}=010$
This gives the address $=\mathrm{XXXXXXXXXX} 010010_{2}=00012_{16}$ with $\mathrm{Xs}=0$
36. The control register address $=\mathrm{XXXXXXXXXX} 010110_{2}=00016_{16}$ with $\mathrm{Xs}=0$

Therefore, the instruction is MOV $[16 \mathrm{H}], 98 \mathrm{H}$.
37. MOV BL,[0408H] ;Read port A

MOV AL,[040AH] ;Read port B
ADD AL,BL ;Add the two readings
MOV [040CH],AL ; Write to port C

## Section 10.8

38. $\mathrm{CLK}_{2}$, GATE $_{2}$, and $\mathrm{OUT}_{2}$.
39. Control word $\mathrm{D}_{7} \mathrm{D}_{6} \mathrm{D}_{5} \mathrm{D}_{4} \mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}=01011010_{2}=5 \mathrm{AH}$.
40. CS---- $=0$, RD---- $=1$, WR---- $=0, \mathrm{~A}_{1}=1$, and $\mathrm{A}_{0}=1$.
41. MOV DX,1003H ; Select the I/O location

MOV AL,5AH ; Get the control word
MOV [DX],AL ; Write it
42. MOV AL, 12H ;Write 12 H to LS byte of counter 2

MOV [1002H],AL
43. MOV AL,10000000B ;Latch counter 2

MOV DX,1003H
MOV [DX],AL
MOV DX,1002H
MOV AL,[DX]
;Read the least significant byte
44. $54.9 \mathrm{~ms} ; 32.8 \mathrm{~ms}$.
45. 838 ns ; 500 ns .
46. 3.43 ms .
47. $\mathrm{N}=48_{10}=30_{16}$.
48. $241 \mu \mathrm{~s}$.

## Section 10.9

49. No.
50. When a peripheral device wants to perform a DMA operation, it makes a request for service at one of the DRQ inputs of the 82C37A. In response to this DMA request, the DMA controller (82C37A) switches its hold request (HRQ) output to logic 1. This signal is applied to the HOLD input of the $8088 / 8086$. In response to this input, the MPU puts the bus signals into the high-impedance state and signals this fact to the DMA controller by switching the hold acknowledge (HLDA) output to logic 1. This output is applied to HLDA input of the 82C37A and signals that the system bus is now available for use by the DMA controller.
51. 27. 
1. To read the current address of DMA channel 0 in a DMA controller located at base address $0010_{16}$, the instructions are:

MOV AL,0H
OUT 1CH,AL ;Clear internal flip-flop to read low byte first
IN AL,10H
MOV BL,AL ;Save low byte in BL
IN AL,10H ;High byte
MOV AH,AL
MOV AL,BL ;AX now contains the contents of the current address register
53. MOV DX,100DH ;Master clear for 82C37A

OUT DX,AL
54. MOV AL,0H ;Output command 0 H to 82 C 37 A

MOV DX,2008H
OUT DX, AL
55. MOV AL,56H ;Load channel 2 mode register

OUT FBH,AL
56. $0 \mathrm{~F}_{16}$.
57. MOV DX,5008H ;Read status register of 82C37A

IN AL,DX

## Section 10.10

58. Clock.
59. Simplex: capability to transmit in one direction only.

Half-duplex: capability to transmit in both directions but at different times.
Full-duplex: capability to transmit in both directions at the same time.
60. -5 V dc to -15 V dc.

## Section 10.11

61. C/D---- = 0, RD---- $=1$, WR---- $=0$, and CS---- $=0$.
62. Asynchronous character length: 8 bits

Parity: even
Number of stop bits: 2
63. MOV AL,FFH

MOV MODE,AL
64. The mode instruction determines the way in which the 8251A's receiver and transmitter are to operate, whereas the command instruction controls the operation. Mode instruction specifies whether the device operates as an asynchronous or synchronous communications controller, how the external baud clock is divided within the 8251 A , the length of character, whether parity is used or not and if used then whether it is even or odd, and also, the number of stop bits in asynchronous mode.

The command instruction specifies the enable bits for transmitter and receiver.
Command instruction can also be used to reset the error bits of the status register, namely parity error flag (PE), overrun error flag (OE), and framing error flag (FE).

The 8251 A device can be initialized by the command instruction by simply writing logic 1 into bit D of command register. Here, the word initialization means returning to the mode-instruction format.

## Section 10.12

65. 12 rows $\times 12$ columns $=144$ keys.
66. $\mathrm{R}_{3} \mathrm{R}_{2} \mathrm{R}_{1} \mathrm{R}_{0}=1011, \mathrm{C}_{3} \mathrm{C}_{2} \mathrm{C}_{1} \mathrm{C}_{0}=1101$.
67. $\mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}=1101$, abcdefg $=1110000$.

## Section 10.13

68. 16 8-bit characters, right-entry for display. Strobed input, and decoded display scan for keyboard.
69. $\mathrm{P}=30$.

CLK $=(100 \mathrm{kHz})(30)=3 \mathrm{MHz}$
70. Command word 0: to set the mode of operation for keyboard and display.

Command word 1: to set the frequency of operation of 8279.
Command word 2: to read the key code at the top of FIFO.
Command word 3: to read the contents of display RAM.
Command word 4: to send new data to the display.
Command word 6: to initialize the complete display memory, the FIFO status, and the interrupt request output line.
Command word 7: to enable or disable the special error mode.

## CHAPTER 11

## Section 11.1

1. External hardware interrupts, software interrupts, internal interrupts, nonmaskable interrupt, and reset.
2. Interrupt service routine.
3. External hardware interrupts, nonmaskable interrupt, software interrupts, internal interrupts, and reset.
4. 0 through 255 .
5. Higher priority.

## Section 11.2

6. Interrupt pointer table.
7. 4 bytes.
8. 16-bit segment base address for CS and 16 -bit offset for IP.
9. Overflow.
10. $\mathrm{IP}_{3}=\mathrm{A} 000 \mathrm{H}$ is stored at address $0 \mathrm{C}_{16}$ and $\mathrm{CS}_{3}=\mathrm{A} 000 \mathrm{H}$ is stored at address $0 \mathrm{E}_{16}$.
11. $\left(\mathrm{IP}_{40}\right)=($ Location A 0 H$)$, and $\left(\mathrm{CS}_{40}\right)=($ Location A 2 H$)$.

## Section 11.3

12. Set interrupt enable.
13. Arithmetic; overflow flag.
14. The MPU goes into the idle state and waits for an interrupt or reset to occur.

## Section 11.4

15. ;This is an uninterruptible subroutine

CLI ; Disable interrupts at entry point
. ; Body of subroutine

STI ; Enable interrupts
RET ; Return to calling program
16. Put an STI instruction at the beginning of the service routine.

## Section 11.5

17. Interrupt acknowledge.
18. Level triggered.
19. INTR is the interrupt request signal that must be applied to the 8088 MPU by external interrupt interface circuitry to request service for an interrupt-driven device. When the MPU has acknowledged this request, it outputs an interrupt acknowledge bus status code
on S----2S----1----S----0, and the 8288 bus controller decodes this code to produce the INTA---- signal. INTA---- is the signal used to tell the external device that its request for service has been granted.
20. 8088; 8288.
21. $\mathrm{D}_{0}$ through $\mathrm{D}_{7}$.
22. S----2S----1 $S----0=000$.

## Section 11.6

23. When the 8088 microprocessor recognizes an interrupt request, it checks whether the interrupts are enabled. It does this by checking the IF. If IF is set, an interrupt acknowledge cycle is initiated. During this cycle, the INTA---- and LOCK---- signals are asserted. This tells the external interrupt hardware that the interrupt request has been accepted. Following the acknowledge bus cycle, the 8088 initiates a cycle to read the interrupt vector type. During this cycle the INTA---- signal is again asserted to get the vector type presented by the external interrupt hardware. Finally, the interrupt vector words corresponding to the type number are fetched from memory and loaded into IP and CS.
24. $1.2 \mu \mathrm{~s}$.
25. $1.8 \mu$ s for three write cycles; 6 bytes.
26. $1.2 \mu \mathrm{~s}$ for two read cycles.

## Section 11.7

27. $\mathrm{D}_{0}=0 \quad \mathrm{ICW}_{4}$ not needed
$\mathrm{D}_{1}=1$ Single-device
$\mathrm{D}_{3}=0$ Edge-triggered
and assuming that all other bits are logic 0 gives
$\mathrm{ICW}_{1}=00000010_{2}=02_{16}$.
28. $\mathrm{ICW}_{2}=\mathrm{D}_{7} \mathrm{D}_{6} \mathrm{D}_{5} \mathrm{D}_{4} \mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}=01110 \mathrm{XXX}_{2}=70_{16}$ through $77_{16}$.
29. $\mathrm{D}_{0}=1 \quad$ Use with the $8086 / 8088$
$D_{1}=0 \quad$ Normal end of interrupt
$\mathrm{D}_{3} \mathrm{D}_{2}=11$ Buffered mode master
$\mathrm{D}_{4}=0 \quad$ Disable special fully nested mode
and assuming that the rest of the bits are logic 0 , we get
$\mathrm{ICW}_{4}=00001101_{2}=0 \mathrm{D}_{16}$.
30. CLI
;Disable interrupts
MOV AX,0H ;Set up data segment
MOV DS,AX
MOV AL,2H ;ICW1 loaded
MOV [A000H],AL
MOV AL,70H ;ICW2 loaded
MOV [A001H],AL
MOV AL,0DH ;ICW4 loaded
MOV [A001H],AL ;Initialization complete
STI
;Enable interrupts
31. MOV AL,[0A001H]
32. $\operatorname{Set} \mathrm{IR}_{7}$ priority as the lowest one.
33. 

MOV AL, [0A001H] ;Read OCW3
MOV [OCW3],AL ;Copy in memory
NOT AL ;Extract RR bit
AND AL,2H ;Toggle RR bit
OR [OCW3],AL ;New OCW3
MOV AL,[OCW3] ;Prepare to output OCW3
MOV [0A001H],AL ;Update OCW3

## Section 11.8

34. 8. 
1. 22. 
1. Assuming that only one of the IR inputs of slave $B$ is active, its INT output switches to logic 1 . This output is applied to the $\mathrm{IR}_{6}$ input of the master 82C59A. Again assuming that no higher priority interrupt is already active, the master 82C59A also switches its INT output to logic 1 . In this way, the MPU is signaled that an external device is requesting service.

As long as the external hardware interrupt interface is enabled, the request for service is accepted by the MPU and an interrupt acknowledge bus cycle initiated. The MPU outputs a pulse to logic 0 at INTA----. This signal is applied to all three 82C59As in parallel and signals them that the request for service has been granted.

In response to this pulse, the master 82C59A outputs the 3-bit cascade code (110) of the device whose interrupt is being acknowledged onto the CAS bus. The slaves read this code and compare it to their internal identification code. In this case slave B identifies a match. Therefore, as the MPU performs a second interrupt acknowledge bus cycle, slave $B$ outputs the type number of the active interrupt on data bus line $D_{0}$ through $D_{7}$. The MPU reads the type number from the data bus and uses it to initiate the service routine. .
37. 64.

## Section 11.9

38. Vectored subroutine call.
39. $\mathrm{CS}_{80}=\mathrm{A} 000 \mathrm{H}$ and $\mathrm{IP}_{80}=0100 \mathrm{H}$.
40. $\mathrm{CS}_{80} \rightarrow$ (Location 142H) and $\mathrm{IP}_{80} \rightarrow$ (Location 140H).

## Section 11.10

41. Type number $2 ; \mathrm{IP}_{2}$ is at location 08 H and $\mathrm{CS}_{2}$ is at location 0 AH .
42. NMI is different from the external hardware interrupts in three ways:
a. NMI is not masked out by IF.
b. NMI is initiated from the NMI input lead instead of from the INTR input.
c. The NMI input is edge-triggered instead of level sensitive like INTR. Therefore, its occurrence is latched inside the 8088 or 8086 as it switches to its active 1 logic level.
43. Initiate a power failure service routine.

## Section 11.11

44. RESET=1.
45. CLK.
46. 8284 .
47. $\mathrm{AD}_{0}$ through $\mathrm{AD}_{15}=$ High -Z
$\mathrm{A}_{16}$ through $\mathrm{A}_{19}=$ High- Z
BHE---- = High-Z
ALE $=0$
DEN---- $=1$ then High-Z
DT/R---- $=1$ then High-Z
RD---- = 1 then High-Z
WR---- = 1 then High-Z
48. FFFFOH
49. 

RESET: MOV AX,0 ;Set up the data segment MOV DS,AX MOV CX,100H ;Set up the count of bytes MOV DI,0A000H ;Point to the first byte MOV [DI],0 ;Write 0 in the next byte INC DI ;Update pointer, counter DEC CX
JNZ NXT ;Repeat for 100H bytes RET ;Return

## Section 11.12

50. Divide error, single step, breakpoint, and overflow error.
51. Vectors 0 through 4.
52. Single step mode; $\mathrm{CS}_{1}: \mathrm{IP}_{1}$.
53. $\mathrm{CS}_{1}$ is held at 00006 H and $\mathrm{IP}_{1}$ is held at $00004 \mathrm{H} ; \mathrm{A} 0200 \mathrm{H}$.

## CHAPTER 12

## Section 12.1

1. System address bus, system data bus, and system control bus.
2. Generate clock signals: CLK88, OSC, and PCLK, generate the power-on reset (RESET) signal, and synchronize the CPU to slow peripheral devices by using the wait state logic to generate the READY signal for the CPU.
3. $060 \mathrm{H}, 061 \mathrm{H}, 062 \mathrm{H}$, and 063 H .
4. 000 H through $00 \mathrm{FH} ; 080 \mathrm{H}$ through 083 H .
5. 

Timer 0-to keep track of the time of the day, generate an interrupt to the microprocessor every 55 ms .
Timer 1-to produce a DMA request every $15.12 \mu$ s to initiate a refresh cycle of DRAM.
Timer 2-has multiple functions, such as to generate programmable tones for the speaker and a record tone for the cassette.
6. Port $\mathrm{PA}=$ input, port $\mathrm{PB}=$ output, and port $\mathrm{PC}=$ input.
7. $\mathrm{PA}_{0}$ through $\mathrm{PA}_{7}$ and $\mathrm{PC}_{0}$ through $\mathrm{PC}_{3}$.
8. $\mathrm{PB}_{3}$.
9. Port $\mathrm{B}\left(\mathrm{PB}_{1}\right)$.
10. Numeric coprocessor (8087) interrupt request (N P NPI), Read/write memory parity check (PCK), and I/O channel check (I/O CH CK).
11. Printer
12. Fixed disk.
13. 384Kbytes.

## Section 12.2

14. CLK88 $=4.77 \mathrm{MHz} ;$ PCLK $=2.385 \mathrm{MHz}$.
15. 4.77 MHz .
16. Input signal - PWR GOOD Output signal - RESET.
17. Pin 21.
18. Input signals - DMA WAIT----, RDY----/WAIT Output signal - READY.
19. Logic 0 at DMA WAIT---- means wait states are required. Logic 0 at RDY----
/WAIT means data are ready and CPU can complete the cycle, thus wait states are not required.
20. 8259A and 8087.
21. 74LS373 latches and 74LS245 bus transceiver.
22. 8288
23. MEMR---- $=\operatorname{pin} 7$ and MEMW---- $=$ pin 8 .
24. See answer for Problem 11.23.

## Section 12.3

25. I/O channel cards; 0 .
26. I/O channel cards (I/O CH RDY), I/O reads or writes (XIOR---- and XIOW----), and DMA cycles (DACK 0 BRD---- or AEN BRD).
27. When a DMA request $\left(\mathrm{DRQ}_{0}\right.$ through $\left.\mathrm{DRQ}_{3}\right)$ goes active (logic 1), 8237A outputs logic 0 at HRQ DMA----. This signal is input to NAND gate $\mathrm{U}_{52}$ in the wait state logic circuit and causes logic 1 at its output. This output drives the CLR input of 74LS74 flipflop $U_{67}$, which produces HOLDA, and releases the cleared flip-flop for operation. The output of NAND gate $\mathrm{U}_{52}$ is also used as an input to NAND gate $\mathrm{U}_{5}$. When the 8088
outputs the status code $\mathrm{S}_{2}---\mathrm{S}_{1}---\mathrm{S}_{0}---=111$ (passive state) and LOCK---- = 1, the output of $\mathrm{U}_{5}$ switches to 0 . This output is inverted to logic 1 at pin 8 of $\mathrm{U}_{83}$.

On the next pulse at CLK, the logic 1 applied to input $\mathrm{D}_{3}$ of flip-flop $\mathrm{U}_{98}$ is latched at output $\mathrm{Q}_{3}$. Next, this output is latched into the 74LS74 flip-flop $\mathrm{U}_{67}$ synchronously with a pulse at CLK88 to make HOLDA logic 1. HOLDA is sent to the HLDA input of 8237A and signals that the 8088 has given up control of the system bus.
28. When the RESET signal is at logic 0 (not active), the 8088 can enable the NMI interface by doing an I/O write operation to any I/O address in the range of 00 A 0 H to 00 BFH with bit $\mathrm{D}_{7}=1$.
29. MOV AL,80H ;Disable NMI OUT 0A0H,AL
30. Yes, output $\mathrm{PB}_{4}$ of $8255 \mathrm{~A} \mathrm{U}_{36}$ is the enable RAM parity check (ENB RAM PCK----) signal. Logic 0 at this output enables the parity check circuit.
31. Since the signals PCK and I/O CH CK are connected to $\mathrm{PC}_{7}$ and $\mathrm{PC}_{6}$ of the 8255A, respectively, the 8088 can read port C to determine which NMI source is requesting service.

| $\frac{\mathrm{PC}_{7}}{7}$ | $\mathrm{PC}_{6}$ | NMI source |
| :---: | :--- | :--- |
| 0 | 0 | N P NPI |
| 0 | 1 | I/O CH CK |
| 1 | 0 | PCK |

## Section 12.4

32. I/O write to address A0H makes

$$
\mathrm{A}_{9} \mathrm{~A}_{8} \mathrm{~A}_{7} \mathrm{~A}_{6} \mathrm{~A}_{5} \mathrm{~A}_{4} \mathrm{~A}_{3} \mathrm{~A}_{2} \mathrm{~A}_{1} \mathrm{~A}_{0}=0010100000
$$

which generates the WRT NMI REG---- signal.
With $\mathrm{A}_{9}$ and $\mathrm{A}_{8}$ logic 0 and AEN---- (Non DMA cycle) logic 1, decoder $\mathrm{U}_{66}$ is enabled for operation. Since $A_{7}$ and $A_{5}$ are 1 and $A_{6}$ is 0 , output $Y_{5}$ of $U_{66}$ switches to logic 0 .
This output is input to a NOR gate along with XIOW----, which is also at logic 0 .
Therefore, the output at pin 10 of $\mathrm{U}_{50}$ is at logic 1 . This signal is inverted to produce the WRT NMI REG---- signal.
33. DMA controller chip select (DMA CS----), interrupt controller chip select (INTR CS-
--- ), interval timer chip select (T/C CS----), and parallel peripheral interface chip select (PPI CS----).
34. CS----0, CS----1, CS----2, CS----3, CS----4, CS----5, CS----6, CS----7.
35. Expressing the address in binary form, we get
$\mathrm{A}_{19} \mathrm{~A}_{18} \mathrm{~A}_{17} \mathrm{~A}_{16} \mathrm{~A}_{15} \mathrm{~A}_{14} \mathrm{~A}_{13} \mathrm{~A}_{12} \mathrm{~A}_{11} \mathrm{~A}_{10} \mathrm{~A}_{9} \mathrm{~A}_{8} \mathrm{~A}_{7} \mathrm{~A}_{6} \mathrm{~A}_{5} \mathrm{~A}_{4} \mathrm{~A}_{3} \mathrm{~A}_{2} \mathrm{~A}_{1} \mathrm{~A}_{0}=11111010000000000000$
As the address FA 000 H is applied at the input of the ROM address decoder circuitry, address bits $\mathrm{A}_{16}$ through $\mathrm{A}_{19}$, which are all 1, drive the inputs of NAND gate $\mathrm{U}_{64}$. This input condition makes the ROM ADDR SEL---- output at pin 6 becomes logic 0 . This signal, along with XMEMR---- (logic 0 ) and RESET DRV---- (logic 1), enables the 74LS138 three-line-to-eight-line decoder $\mathrm{U}_{46}$. The inputs of this decoder are $\mathrm{A}_{15} \mathrm{~A}_{14} \mathrm{~A}_{13}=$ 101. Therefore, output CS----5 switches to its active 0 level. CS---- 5 enables EPROM $\mathrm{XU}_{31}$ in the ROM array, and the signal ROM ADDR SEL---- controls the data direction through the 74LS245 bus transceiver $\mathrm{U}_{13}$.
36. $\mathrm{A}_{19} \mathrm{~A}_{18}=00$.
37. RAS----1
38. CAS----2

## Section 12.5

39. For the address $\mathrm{F} 4000{ }_{16}$ we have $\mathrm{A}_{16}$ through $\mathrm{A}_{19}=1111, \mathrm{~A}_{14}=1$, and the rest of the address bits are 0 . Since $\mathrm{A}_{16}$ through $\mathrm{A}_{19}=1111$, ROM ADDR SEL---- is at its active 0 logic level. This output enables the 74LS138 decoder, $\mathrm{U}_{46}$. Since $\mathrm{A}_{15} \mathrm{~A}_{14} \mathrm{~A}_{13}=010$, CS--${ }_{-2}$ is active. CS----2 selects $\mathrm{XU}_{28}$ in the ROM array and data are read from the first storage location of the EPROM chip. Also, ROM ADDR SEL---- directs the data from ROM to the 8088 via the 74LS245 bus transceiver $\mathrm{U}_{13}$.
40. When a byte of data is written to the DRAMs in bank 0 , the RAS and CAS address bytes are output from the address multiplexer synchronously with the occurrence of the active RAS ---0 and CAS ---0 address strobe signals. ADDR SEL initially sets the 74LS158 address multiplexer ( $\mathrm{U}_{62}$ and $\mathrm{U}_{79}$ ) to output the RAS address byte to the DRAMs on multiplexed address lines $\mathrm{MA}_{0}$ through MA7. When RAS----0 switches to logic 0, it signals all DRAMs in bank 0 to accept the row address off the MA lines. Next, ADDR SEL switches logic levels and causes the column address to be output from the multiplexer to the MA lines. It is accompanied by CAS----0, which is applied in parallel to the CAS---- inputs of all DRAMs in bank 0 . Logic 0 at these inputs tells the DRAMs to accept the CAS address off the MA lines.

At this point, the address has selected the storage location to be accessed. Next, the data to be written into this storage location is supplied from the data bus of the MPU through the 74LS245 transceiver $\left(\mathrm{U}_{12}\right)$ to the data line of DRAMs $\mathrm{U}_{38}-\mathrm{U}_{45}$. The same byte of data is also applied to the parity generator circuit where the corresponding parity bit is generated and stored in $\mathrm{U}_{37}$. The data is written into bank 0 synchronous with a pulse at WE----.

## Section 12.6

41. DMA requests for channels 1,2 , and 3 are the $\mathrm{I} / \mathrm{O}$ channel devices (boards plugged into the I/O channel).
42. We will assume that none of the DRQ inputs of the 8237A are masked out and that a DMA operation is not already in progress. When any of the DRQ lines switches to logic 1, the 8237A makes its hold request (HRQ) output become logic 1. This signal is inverted to give logic 0 at HRQ DMA----. HRQ DMA---- is applied to the input of the wait state logic and initiates a request to the MPU for use of the system bus by the DMA controller.

When the 8088 is ready to give up control of the system bus, it signals this fact to the 8237A DMA controller. The wait state logic circuitry also performs this function. When the buses are in the passive state, the MPU switches the HOLDA output to logic 1. This signal is returned to the HLDA input of the 8237A and indicates that the buses are available for use by the DMA controller.

The processing of the HRQ DMA---- input and generation of the HOLDA output by the wait state logic circuitry is described in the solution for problem 27.
43.

DMA page register Contents

| 1 | 0 AH |
| :--- | :--- |
| 2 | 0 BH |
| 3 | 0 CH |

Instruction sequence:
MOV AL,0AH ;Init. channel 1 page register
OUT 81H,AL
MOV AL,0BH ;Init. channel 2 page register
OUT 82H,AL
MOV AL,0CH ;Init. channel 3 page register
OUT 83H,AL

## Section 12.7

44. Timer interrupt frequency $=1 / 54.936 \mathrm{~ms}=18.2 \mathrm{~Hz}$

Refresh request frequency $=1 / 15.12 \mu \mathrm{~s}=66.14 \mathrm{KHz}$
45. Counter 1 divisor $=1.1 \mathrm{M} / 18.2=60,440$
46. When the speaker is to be used, the 8088 must write logic 1 to bit 0 of port $B$ of the 8255A to produce the signal TIM 2 GATE SPK that enables the clock for timer 2. Pulses are now produced at $\mathrm{OUT}_{2}$. When a tone is to be produced by the speaker, the 8088 outputs the signal SPKR DATA at pin 1 of port B. This signal enables the pulses output at $\mathrm{OUT}_{2}$ to the 75477 driver. The output of the driver is supplied to the speaker.
Changing the count in timer 2 can change the frequency of the tone.
47.

48.

MOV AL, SW1_EN ;Enable SW1 buffer
OUT 61H, AL
IN AL, 60H :Input SW1
MOV [SW1_LOC], AL ;Save SW1
MOV AL, SW1_DIS ;Disable SW1 buffer
OUT 61H, AL
; Where, SW1_EN is a byte with MSB $=1$
; $\quad$ SW_DIS is a byte with MSB $=0$
; SW1_LOC is a location where SW1 is saved.

## Section 12.8

49. KBD IRQ is an output that is used as an interrupt to the MPU and, when active, it signals that a keyscan code needs to be read.
50. 

KBR_SRV: PUSH AX ;Save register to be used
MOV AL, KEYBDCLK_LOW
OUT 61H, AL
MOV AL, SR_EN ;Enable the shift register output
OUT 61H, AL
IN AL, 60H ;Input the key code
MOV [KBD_LOC], AL
;Save the keycode
MOV AL, KEYBDCLK_EN
OUT 61H, AL
POP AX ;Restore register
IRET
;Return
; Where, KEYBDCLK_LOW is a byte with bit $6=0$
; KEYBDCLK_EN is a byte with bit $6=1$
; $\quad$ SR_EN is a byte with the $\mathrm{MSB}=0$
; KBD_LOC is a byte location where the key code is saved

## Section 12.9

51. I/O channel slots provide the system interface to add-on cards. Five 62-pin card slots are provided on the system board.
52. $\mathrm{A}_{10}$. Active high.

## Chapter 13

## Section 13.1

1. Prototype circuit.
2. A circuit card that is used to prototype an experimental circuit.
3. Solderless breadboard.
4. An extender card is plugged into the I/O channel slot of the PC (ISA slot for a PC/AT) and the card to be tested is plugged into the top of the extender card. This elevates the circuits on the board above the housing of the PC to permit easy access for testing.
5. Bus interface module, I/O expansion bus cables, breadboard unit

## Section 13.2

6. Switches, LEDs, and a speaker.
7. The INT/EXT switch must be set to the EXT position.
8. One.
9. 26 AWG.
10. The horizontal row marked with a line.
11. $A_{31}$ through $A_{12}$.
12. Test for continuity between two points in a circuit; the buzzer sounds if continuity exists between the test points.
13. Logic 0 lights the green LED; logic 1 lights the red LED; and the high- Z level lights the amber LED.
14. The red LED marked $P$ blinks.

## Section 13.3

15. 74LS688, 74LS138, and 74LS32.
16. IOWX31E----
17. $\mathrm{A}_{10}$ through $\mathrm{A}_{15}$.
18. Yes; IOWX31E----
19. The select outputs of the 74LS138 are gated with either IOR---- or IOW---- in

74LS32 OR gates. These signals are active only during an I/O cycle.
20. $\mathrm{D}_{7} \mathrm{D}_{6} \mathrm{D}_{5} \mathrm{D}_{4} \mathrm{D}_{3} \mathrm{D}_{2} \mathrm{D}_{1} \mathrm{D}_{0}=00001111_{2}$
21. Yes
22.

MOV DX,31DH ;Read the switches
IN AL,DX ;Mask off all but S1 and S0
AND AL,3H
CMP AL,3H
JZ SERVE_3 ;Branch to SERVE_3 of S1 \& S1 are closed
23. The setting of switch 7 is polled waiting for it to close.
24. LED 0; LED 7.
25. Lights LEDs 0 through 3.
26.

|  | MOV | DX,31EH | ;Select LED port address |
| :---: | :--- | :--- | :--- |
|  | MOV | AL,01H | ;Select code for 1st LED |
| SCAN: | OUT | DX,AL | ;Write to light next LED |
|  | MOV | CX,0FFFFH | ;Wait a while |
| DELAY: | DEC | CX |  |
|  | JNZ | DELAY |  |
|  | ROL | AL,1 | ;Select code for next LED |
|  | JMP | SCAN | ;Repeat |

27. The LEDs are lit in a binary counting pattern.
28. 75477. 
1. Change MOV CX,0FFFFH to MOV CX,7FFFH.

## Section 13.4

30. IN AL, 8000 H reads the switch setting into the LSB of AL. Logic 0 in a bit position indicates that the corresponding switch is open.
31. 


31. (Continued)

32. Diagnostic program.
33. IC test clip.
34. Logic probe, multimeter, and oscilloscope.
35. Whether the test point is at the 0,1 , or high- $Z$ logic state, or if it is pulsating.
36. The multimeter reads the actual voltage present at a test point.
37. Amount of voltage, duration of the signal, and the signal waveshape.
38. The signal waveshape pattern repeats at a regular interval of time.
39. Troubleshooting.
40. Software debug.
41. Hardware troubleshooting.
42.
i) Programming of VLSI peripherals
ii) Addresses of I/O devices or memory locations
iii) Algorithm implementation
43.
i) Check to verify that correct pin numbers are marked into the schematic diagram.
ii) Verify that the circuit layout diagram correctly implements the schematic.
iii) Check that the ICs and jumpers are correctly installed to implement the circuit.
44. Power supply voltages.
45.

Test point Switch open Switch closed

| 1 | 1 | 0 |
| :---: | :---: | :---: |
| 2 | 1 | 0 |
| 3 | Pulse | Pulse |

46. The jumper from the switch to the junction of the resistor and pin 1 of the 74LS240 is not making contact.

## Section 13.5

47. Address bus, data bus, and control-bus signals.
48. Digital logic analyzer.
49. 

Oscilloscope Logic analyzer
i) Requires periodic signal to display
ii) Small number of channels
i) Can display periodic or nonperiodic signals
iii) Displays actual voltage values
iv) Generally does not store
the signals for display
ii) Large number of channels
iii) Displays logic values
v) Simple trigger condition using a single signal
iv) Stores signals for display
v) Trigger signal can be a combination of a number of signals

## Chapter 14

## Section 14.1

1. HMOSIII.
2. 125,000 .
3. PLCC, LCC, and PGA.

## Section 14.2

4. Bus unit, instruction unit, execution unit, and address unit.
5. 24 bits, 16 bits.
6. Demultiplexed address and data buses.
7. 6 bytes.
8. Address generation, address translation, and address checking.
9. The queue holds the fetched instructions for the execution unit to decode and perform the operations that they specify.

## Section 14.3

10. $5 \times$.
11. That an 8086 object code program can run on the 80286 .
12. Machine status word register (MSW).

## Section 14.4

13. Saves the contents of various registers of the processor such as $A X, S P$, and so forth, on the stack.
14. DI, SI, BP, SP, BX, DX, CX, and AX.
15. Data area on the stack for a subroutine to provide space for the storage of local variables, linkage to the calling subroutine, and the return address.
16. 32 bytes for data +10 bytes for the previous and current frame pointers; 4 .
17. A word of data from the word size port at address 1000 H is input to the memory address $1075 \mathrm{H}: 100 \mathrm{H}$. The SI register is incremented to 102 H , and CX is decremented by 2.
18. The 16 bytes of data in the range $1075 \mathrm{H}: 100 \mathrm{H}$ through $1075 \mathrm{H}: 0 \mathrm{~F} 0 \mathrm{H}$ are output one after the other to the byte-wide output port at I/O address 2000 H . Each time a byte is output, the count in the CX register and the pointer in SI are decremented by 1 . The output sequence is repeated until the count in CX is 0 .
19. The instruction tests if VALUE lies between 0000 H and 00 FFH . If it is outside these bounds, interrupt 5 occurs.

## Section 14.5

20. 20-bits, 1 Mbyte; 24-bits, 16 Mbyte; 1 GByte.
21. I/O write (output bus cycle).
22. Byte transfer over the upper eight data bus lines.
23. No, it is one bit of a status code that must be decoded to produce an interrupt acknowledge signal.
24. HOLD and HLDA.
25. 80287. 

## Section 14.6

26. M/IO----, $S_{1----, ~} S_{0----}$.
27. IOWC----
28. DT/R----, ALE, and DEN.
29. 30. 

## Section 14.7

30. $8 \mathrm{MHz}, 10 \mathrm{MHz}$, and 12.5 MHz ; 80286, 80286-10, and 80286-12, respectively.
31. 25 MHz .
32. CLK and PCLK; 10 MHz and 5 MHz .

Section 14.8
33. Four clocks; 400 ns .
34. Send-status state, 80286 outputs the bus status code to the 82 C 288 and in the case of a write (or output) bus cycle it also outputs data on the data bus.
35. Perform-command state; external devices accept write data from the bus, or in the case of a read cycle, place data on the bus.
36. In Fig. 14.26(a) address $n$ becomes valid in the $T_{c}$ state of the prior bus cycle and then the data transfer takes place in the next $\mathrm{T}_{\mathrm{c}}$ state. Also, at the same time that data transfer $n$ occurs address $n+1$ is output on the address bus. This shows that due to pipelining the 80286 starts to address the next storage location that is to be accessed while it is still reading or writing data for the previously addressed storage location.
37. An idle state is a period of no bus activity that occurs because the prefetch queue is already full and the instruction currently being executed requires no bus activity.
38. An extension of the current bus cycle by a period equal to one $\mathrm{T}_{\mathrm{s}}$ state because the READY---- input was tested and found to be logic $1 ; 600 \mathrm{~ns}$.

## Section 14.9

39. The bus controller produces the appropriately timed command and control signals needed to control transfers over the data bus. The decoder decodes the higher-order address bits to produce chip-enable signals. The address latch is used to latch and buffer the lower bits of the address and chip-enable signals. The data bus buffer/transceiver controls the direction of data transfers between the MPU and memory subsystem.
40. 110; MWTC----.
41. Odd-addressed byte, even-addressed byte, even-addressed word, and odd-addressed word. One bus cycle is required for all types of cycles, except the odd-addressed word cycle, which requires two bus cycles.
42. $500 \mathrm{~ns} ; 1 \mu \mathrm{~s}$.
43. Odd-addressed byte.
44. 

a. At the beginning of $\phi_{2}$ of the $T_{c}$ state in the previous bus cycle, the address, $\mathrm{M} / \mathrm{IO}---$ and COD/INTA---- signals for the byte-write bus cycle are output.
b. Status code $S---{ }_{1} S---{ }_{0}$ equal to 10 is output on the status bus at the beginning of $\phi_{1}$ of the write cycle and is maintained throughout the $\mathrm{T}_{\mathrm{s}}$ state. On the falling edge of CLK in the middle of $\mathrm{T}_{\mathrm{s}}$ the 82C288 bus controller samples the status lines and the write cycle bus control sequence is started.
c. At the beginning of $\phi_{2}$ of $T_{s}$, ALE is switched to logic 1. This pulse is used to latch the address. Also DEN is switched to 1 to enable the data bus transceivers and DT/R---- is left at the
transmit level to set the transceivers to output data to the memory subsystem.
d. At the beginning of $\phi_{2}$ in the $T_{\mathrm{s}}$ state the byte of data to be written to memory is output on bus lines $\mathrm{D}_{0}$ through $\mathrm{D}_{7}$.
e. At the start of $\phi_{1}$ of the $T_{c}$ state, MWTC---- is switched to its active 0 logic level to signal the memory subsystem to read the data off the bus.
f. Late in $T_{c}$ the 80286 and 82C288 test the logic level of READY----. If it is logic 0 , the write cycle is completed.
45. 320 ns .
46. 480 ns.

## Section 14.10

47. M/IO----.
48. 82C288.
49. The decoder is used to decode several of the upper I/O address bits to produce the I/OCE---- signals. The latch is used to latch the lower-order address bits and I/OCE---outputs of the decoder. The bus controller decodes the I/O bus commands to produce the I/O and bus control signals for the I/O interface. The bus transceivers control the direction of data transfer over the bus.
50. 600 ns.
51. $1.2 \mu \mathrm{~s}$.
52. During the $T_{c}$ state of the previous bus cycle, the 80286 outputs the I/O address along with BHE---- $=0$ and $\mathrm{M} / \mathrm{IO}----=0$. The address decoder decodes some of the address bits to produce I/O chip enable signals. At the beginning of the $\mathrm{T}_{\mathrm{s}}$ state of the output cycle, $\mathrm{S}-\mathrm{-}_{-1} \mathrm{~S}---{ }_{0}=10$ is output to signal that an output operation is in progress. The 82C288 decodes this bus status code and starting at $\phi_{2}$ of the $\mathrm{T}_{\mathrm{s}}$ state a pulse is output at ALE. This pulse is used to latch the I/O address and chip enable signals into the address latch. At the same time DEN is switched to 1 and DT/R---- is held at the transmit level (logic 1). Therefore, the bus transceivers are enabled and set up to pass data from the 80286 to I/O port. Finally, at the beginning of the $\mathrm{T}_{\mathrm{c}}$ state the bus controller switches IOWC---- to logic 0 to signal the I/O device to read data off the bus.

## Section 14.11

53. Hardware interrupts, software interrupts, internal interrupts and exceptions, software interrupts, and reset.
54. 0 through 255.
55. Interrupt vector table; interrupt descriptor table.
56. 2 words.
57. Interrupt descriptor table register, 0 .
58. $\mathrm{CS}_{3}=\mathrm{A} 000 \mathrm{H}$ and $\mathrm{IP}_{3}=\mathrm{A} 000 \mathrm{H}$.
59. INTR is the interrupt request signal that must be applied to the 80286 MPU by the external interrupt interface circuitry to request service for an interrupt-driven device.
When the MPU acknowledges this request, it outputs an interrupt acknowledge bus status code on M/IO---- S---- ${ }_{1} \mathrm{~S}---{ }_{0}$, and this code is decoded by the 82 C 288 bus controller to produce the INTA---- signal. INTA---- is the signal that is used to tell the external device that its request for service has been granted.
60. 8 .
61. Divide Error,

Single step,
Breakpoint,
Overflow error,
Bounds check,
Invalid opcode,
Processor extension not available, Interrupt table limit to small,
Processor extension segment overrun, Segment overrun, Processor extension error.
62. Vectors 0 through 16.

## Chapter 15

## Section 15.1

1. 80386 DX and 80386 SX .
2. 32 bit registers and a 32 -bit data bus; 32 bit registers and a 16-bit data bus.
3. $39 ; 49$.
4. Real-address mode, protected-address mode, and virtual 8086 mode.

## Section 15.2

5. Bus unit, prefetch unit, decode unit, execution unit, segment unit, and page unit.
6. 32 bit, 32 bit.
7. Separate address and data buses.
8. 16 bytes.
9. Prefetch unit.
10. 6 word $\times 64$ bit.
11. Translation lookaside buffer.

## Section 15.3

12. $5 \times$
13. Object code compatible means that programs and operating systems written for the 8088/8086 will run directly on the 80386DX and 80386SX in real-address mode.
14. 32 bits; 16 bits.
15. $\mathrm{FS}, \mathrm{GS}$, and $\mathrm{CR}_{0}$ registers.

## Section 15.4

16. MOV EBX,CR1
17. Double precision shift left.
18. The byte of data in BL is sign-extended to 32 bits and copied into register EAX.
19. MOVZX EAX, [DATA_WORD].
20. The first 32 bits of the 48 -bit pointer starting at memory address

DATA_F_ADDRESS are loaded into EDI and the next 16 bits are loaded into the FS register.
21. (a) $(\mathrm{AX})=\mathrm{F} 0 \mathrm{FOH},(\mathrm{CF})=1$.
(b) $(\mathrm{AX})=\mathrm{F} 0 \mathrm{E} 0 \mathrm{H},(\mathrm{CF})=1$.
(c) $(\mathrm{AX})=\mathrm{F} 0 \mathrm{E} 0 \mathrm{H},(\mathrm{CF})=1$.
22. Set byte if not carry; $(\mathrm{CF})=0$.

## Section 15.5

23. Global descriptor table register, interrupt descriptor table register, task register, and local descriptor table register.
24. LIMIT and BASE.
25. Defines the location and size of the global descriptor table.
26. GTD $_{\text {START }}=210000 \mathrm{H}, \mathrm{GDT}_{\mathrm{END}}=2101 \mathrm{FFH} ; \mathrm{SIZE}=512$ bytes; DESCRIPTORS $=$ 64
27. System segment descriptors.
28. Interrupt descriptor table register and interrupt descriptor table.
29. 0 FFFH
30. Interrupt gates.
31. Local descriptor table.
32. Selector; the LDT descriptor pointed to by the selector is cached into the LDT cache.
33. $\mathrm{CR}_{0}$.
34. PE
35. $(\mathrm{MP})=1,(E M)=0$, and $(E T)=1$.
36. Task switched.
37. Switch the PG bit in $\mathrm{CR}_{0}$ to 1 .
38. $\mathrm{CR}_{3}$.
39. 4Kbyte
40. Page frame addresses.
41. Selector; selects a task state segment descriptor.
42. The selected task state segment descriptor is loaded into this register for on-chip access.
43. BASE and LIMIT of the TSS descriptor.
44. Code segment selector register; data segment selector register.
45. $\mathrm{RPL}=2$ bits
$\mathrm{TI}=1$ bit
INDEX = 13 bits
46. Access the local descriptor table.
47. 00130020 H
48. $\mathrm{NT}=$ nested task; $\mathrm{RF}=$ resume flag.
49. Level 2
50. 48 bits.
51. Selector and offset.
52. 4Gbyte, 1 byte
53. 64 Tbyte, 16,384 segments.
54. 32 Tbyte, 8192 .
55. Task 3 has access to the global memory address space and the task 3 local address space, but it cannot access either the task 1 local address space or task 2 local address space.
56. Memory management unit.
57. The first instruction loads the AX register with the selector from the data storage location pointed to by SI. The second instruction loads the selector into the code segment selector register. This causes the descriptor pointed to by the selector in CS to be loaded into the code segment descriptor cache.
58. 00200100 H
59. $1,048,496$ pages; 4096 bytes long.
60. Offset field $=20$ bit; page field $=10$ bit; directory field $=10$ bit.
61. Cache page directory and page table pointers on-chip.
62. 4Kbytes; offset of the linear address.

## Section 15.6

63. 8 , BASE $=32$-bits, LIMIT $=20$-bits, ACCESS RIGHTS BYTE $=8$-bits,

AVAILABLE $=1$ bit, and GRANULARITY $=1$ bit.
64. CS, DS, ES, FS, GS, or SS; GDTR or LDTR.
65. LIMIT $=00110 \mathrm{H}, \mathrm{BASE}=00200000 \mathrm{H}$.
66. ACCESS RIGHTS BYTE $=1 \mathrm{AH}$
$\mathrm{P}=0=$ Not in physical memory
$\mathrm{E}=1, \mathrm{R}=1=$ Readable code segment
A $=0=$ Descriptor is not cached.
67. 00200226 H
68. 20 most significant bits of the base address of a page table or a page frame.
69. $R / W=0$ and $U / S=0$ or $R / W=1$ and $U / S=0$.
70. Page fault.
71. Dirty bit.

## Section 15.7

72. (INIT_GDTR) $=$ FFFFH
$($ INIT_GDTR + 2) $=0000 \mathrm{H}$
$($ INIT_GDTR +4$)=0030 \mathrm{H}$
73. LMSW AX ;Get MSW

AND AX,0FFF7H ;Clear task-switched bit
SMSW AX ;Write new MSW
74. MOV BX, $2 \mathrm{~F} 0 \mathrm{H} \quad ;(\mathrm{BX})=$ selector

LLDT BX ;Load local descriptor table register with selector

## Section 15.8

75. The running of multiple processes in a time-shared manner.
76. A collection of program routines that perform a specific function.
77. Local memory resources are isolated from global memory resources and tasks are isolated from each other.
78. The descriptor is not loaded; instead, an error condition is signaled.
79. Level 0 , level 3 .
80. Level 3.
81. LDT and GDT.
82. Use of a separate LDT for each task.
83. Level 0 .
84. Current privilege level, requested privilege level.
85. A task can access data in a data segment at the CPL and at all lower privilege levels, but it cannot access data in segments that are at a higher privilege level.
86. Level 3.
87. A task can access code in segments at the CPL or at higher privilege levels, but cannot modify the code at a higher privilege level.
88. Level 0 , level 1 , and level 2.
89. The call gate is used to transfer control within a task from code at the CPL to a routine at a higher privilege level.
90. Execution of this instruction initiates a call to a routine at a higher privilege level through the call gate pointed to by address NEW_ROUTINE.
91. Identifies a task state segment.
92. Defines the state of the task that is to be initiated.
93. The state of the prior task is saved in its own task state segment. The linkage to the prior task is saved as the back link selector in the first word of the new task state segment.
94. TR

## Section 15.9

96. Bit 17.
97. Active, level 3.
98. Yes.
99. Yes.

## Section 15.10

100. Floating-point math coprocessor and code and data cache memory.
101. The 80486 SX does not have an on-chip floating-point math coprocessor.
102. 136; 249.
103. 32 bytes.
104. Complex instruction set computer, reduced instruction set computer, complex reduced instruction set computer.
105. Small instruction set, limited addressing modes, and single clock execution for instructions.
106. CRISC
107. Cache disable (CD) and not write-through (NW).
108. Little Endian.
109. FOFOH.
110. |  | MOV CX, COUNT |
| :--- | :--- |
|  | MOV SI, BIG_E_TABLE |
|  | MOV DI, LIT_E_TABLE. |
|  | NXTDW: |
|  | MOV EAX, [SI] |
|  | SWAP EAX |
|  | MOV [DI, EAX |
|  | ADD SI, 04H |
|  | ADD DI, 04H |
|  | LOOP NXTDW |
111. XADD [SUM], EBX
(EAX) (SUM)
$01 \mathrm{H} \quad 00 \mathrm{H}$
$01 \mathrm{H} \quad 01 \mathrm{H}$ 1st execution
$01 \mathrm{H} \quad 02 \mathrm{H}$ 2nd execution
$02 \mathrm{H} \quad 03 \mathrm{H} \quad 3 \mathrm{rd}$ execution
$03 \mathrm{H} \quad 05 \mathrm{H} \quad 4$ th execution
112. Since the contents of the destination operand, memory location DATA, and register AL are the same, ZF is set to 1 and the value of the source operand, $22_{16}$ is copied into destination DATA.
113. Alignment check (AC); bit 18.
114. Cache disable (CD) and not write-through (NW).
115. INVD
116. WBINVD initiates a write back bus cycle instead of a flush bus cycle.
117. Page cache disable (PCD) and page write transparent (PWT).

## Section 15.11

118. | Integer | Fraction |
| :--- | :--- |
| $9 \div 2 \rightarrow 1$ | $2 \times .5$ |
| $4 \div 2 \rightarrow 0$ | $2 \times 1.0 \rightarrow 1$ |
| $2 \div 2 \rightarrow 0$ | $.5=.1_{2}$ |
| $1 \div 2 \rightarrow 1$ |  |
| $9=1001_{2}$ |  |
| $-9.5=-1001.1_{2}=-1.0011 \times 2^{+3}$ |  |
119. Single precision number $=32$ bits, double precision number $=64$ bits, and extended precision number $=80$ bits
120. Sign, biased exponent, and fractional significand (extended has full significand).
121. $\operatorname{Sign}=1$

Biased exponent $=+3+127=00000011_{2}+01111111_{2}=10000010$
Fractional significand $=00110000000000000000000$
$-1.0011 \times 2^{+3}=11000001000110000000000000000000$;
$-1.0011 \times 2^{+3}=\mathrm{C} 1180000 \mathrm{H}$
122. $8, \mathrm{R} 0$ through $\mathrm{R} 7, \mathrm{ST}(0)$ through $\mathrm{ST}(7)$.
123. $\mathrm{R}_{2}, 5, \mathrm{R}_{5}$.
124. TOP is decremented so that the new top of stack is $R_{4}$ and the value from the old $\mathrm{ST}(2), \mathrm{R}_{7}$, is copied into $\mathrm{R}_{4}$.
125.
$\mid($ DATA4_64B) - (DATA3_64B) $\mid \rightarrow$ DATA5_64B
$|-10.75-(-2.5)|=|-10.75+2.5|=|-8.25|=8.25$
$8.25=1000.01_{2}=1.00001 \times 2^{+3}$
Sign $=0$
Biased exponent $=00000000011_{2}+01111111111_{2}=10000000010$
Fractional significand $=0000100000000000000000000000000000000000000000000000$
$8.25=01000000001000001000000000000000000000000000000000000000000000000$
$8.25=0100000000100000100000000000000000000000000000000000000000000000_{2}$
$8.25=4020800000000000 \mathrm{H}$

## Section 15.12

126. 64 bits.
127. A microprocessor architecture that employs more than one execution unit.
128. 735 .
129. 2; $U$ pipe and $V$ pipe.
130. Separate code and data caches; write-through or write-back update methods; dual port ALU interface.
131. 5 to 10 times faster.
132. ID, VIP, and VIF.
133. Page size extensions, 1M 32-bit entries.
134. Machine check exception.
135. Compare and exchange 8 bytes (CMPXCHG8B), CPU identification (CPUID), and read from time stamp counter (RDTSC).
136. $\mathrm{ZF} \leftarrow 0 ;($ EDX $: \mathrm{EAX}) \leftarrow(\mathrm{TABLE})=11111111 \mathrm{FFFFFFFF}_{16}$
137. Machine check type (MCT).

## Section 15.13

138. Single instruction multiple data.
139. Packed byte, packed word, packed double word, and packed quad-word; $8 \times 8$-bit, $4 \times 16$-bit, $2 \times 32$-bit, and $1 \times 64$-bit.
140. 64-bits wide; $\mathrm{MM}_{0}$ through $\mathrm{MM}_{7}$.
141. 

(a) Byte $7=\mathrm{FFH}$, Byte $6=00 \mathrm{H}$, Byte $5=12 \mathrm{H}$, Byte $4=34 \mathrm{H}$, Byte $3=56 \mathrm{H}$, Byte $2=$ 78 H , Byte $1=\mathrm{ABH}$, Byte $0=\mathrm{CDH}$.
(b) Word $3=$ FF00H, Word $2=1234 \mathrm{H}$, Word $1=5678 \mathrm{H}$, Word $0=\mathrm{ABCDH}$
(c) Double word $1=$ FF001234H Double word $0=5678 \mathrm{ABCDH}$
142.

Byte $7 \quad \mathrm{FFH}+00 \mathrm{H}=\mathrm{FFH}$
Byte $6 \quad \mathrm{FFH}+01 \mathrm{H}=100 \mathrm{H} \rightarrow \mathrm{FFH}$ due to saturation
Byte $5 \quad \mathrm{FFH}+00 \mathrm{H}=\mathrm{FFH}$
Byte $4 \quad \mathrm{FFH}+02 \mathrm{H}=101 \mathrm{H} \rightarrow \mathrm{FFH}$ due to saturation
Byte $3 \quad 12 \mathrm{H}+87 \mathrm{H}=99 \mathrm{H}$
Byte $2 \quad 34 \mathrm{H}+65 \mathrm{H}=99 \mathrm{H}$
Byte $1 \quad 56 \mathrm{H}+43 \mathrm{H}=99 \mathrm{H}$
Byte $0 \quad 78 \mathrm{H}+21 \mathrm{H}=99 \mathrm{H}$
$\mathrm{MM}_{3}=$ FFFFFFFF99999999H
143. Data is compared as signed numbers. This gives

Double word 1 FFFFFFFFH $>00010002 \mathrm{H}=$ False $\rightarrow 00000000 \mathrm{H}$
Double word $0 \quad 12345678 \mathrm{H}>876554321 \mathrm{H}=$ True $\rightarrow$ FFFFFFFFH
$\mathrm{MM}_{3}=00000000 \mathrm{FFFFFFFFH}$
144.
$\mathrm{MM}_{5}$ Byte $7 \quad 01 \mathrm{H}$
Byte $6 \quad$ FFH $\rightarrow$ FFH Unsigned saturation overflow
Byte $5 \quad 00 \mathrm{H} \rightarrow 00 \mathrm{H}$ Unsigned saturation underflow
Byte $4 \quad 23 \mathrm{H} \rightarrow$ FFH Unsigned saturation overflow
$\mathrm{MM}_{6}$ Byte $3 \quad 00 \mathrm{H} \rightarrow 00 \mathrm{H}$ Unsigned saturation underflow
Byte $200 \mathrm{H} \rightarrow 00 \mathrm{H}$ Unsigned saturation underflow
Byte 100 H
Byte $0 \quad 21 \mathrm{H} \rightarrow$ FFH Unsigned saturation overflow
$\mathrm{MM}_{6}=01 \mathrm{FF} 00 \mathrm{FF} 000000 \mathrm{FFH}$

## Chapter 16

## Section 16.1

1. CHMOSIII.
2. 275,000.
3. INTR.

## Section 16.2

4. 20-bits, 1Mbyte; 32-bits, 4Gbyte; 64Tbyte.
5. Byte, $\mathrm{D}_{0}$ through $\mathrm{D}_{7}$, no.
6. $1011,0111,0011$.
7. I/O data read.
8. HOLD and HLDA.
9. 80387DX numeric coprocessor.

## Section 16.3

10. $16 \mathrm{MHz}, 20 \mathrm{MHz}$, 25 MHz , and 33 MHz ; 80386DX-16, 80386DX-20, 80386DX-25, and 80386DX-33, respectively.
11. F12.
12. 50 MHz .

## Section 16.4

13. 40 ns .
14. Pipelined and nonpipelined.
15. In Fig. 16.11 address $n$ becomes valid in the $T_{2}$ state of the prior bus cycle and then the data transfer takes place in the next $\mathrm{T}_{2}$ state. Also, at the same time that data transfer $n$ occurs, address $n+1$ is output on the address bus. This shows that during pipelining, the 80386DX starts to address the next storage location to be accessed while still reading or writing data for the previously addressed storage location.
16. An idle state is a period of no bus activity that occurs because the prefetch queue is full and the instruction currently being executed does not require any bus activity.
17. An extension of the current bus cycle by a period equal to one or more $T$ states because the READY--- input was tested and found to be logic 1.
18. $\mathrm{T}_{1}$ and $\mathrm{T}_{2}$.
19. 80 ns .
20. 160 ns.

## Section 16.5

21. Four independent banks each organized as $1 \mathrm{G} \times 8$ bits; four banks each organized as $256 \mathrm{~K} \times 8$ bits.
22. 

Types of data transfer No. of bus cycles
Byte transfer 1

Aligned word transfer 1
Misaligned word transfer 2
Aligned double-word transfer $\quad 1$
Misaligned double-word transfer 2
23. $120 \mathrm{~ns} ; 240 \mathrm{~ns}$.
24. Higher-addressed byte.
25.

The bus control logic produces the appropriately timed command and control signals needed to control transfers over the data bus.

The address decoder decodes the higher-order address bits to produce chip-enable signals.

The address bus latch is used to latch and buffer the lower bits of the address, byteenable signals, and chip-enable signals.

The bank write control logic determines to which memory banks MWTC--- is applied during write bus cycles.

The data bus transceiver/buffer controls the direction of data transfers between the MPU and memory subsystem and supplies buffering for the data bus lines.
26. M/IO---D/C---W/R--- = 1112, all four, MWTC---.

## Section 16.6

27. M/IO---
28. Bus control logic.
29. 

The I/O address decoder is used to decode several of the upper I/O address bits to produce the I/OCE--- signals.

The I/O address bus latch is used to latch lower-order address bits, byte-enable signals, and I/OCE--- outputs of the decoder.

The bus-control logic decodes I/O bus commands to produce the input/output and buscontrol signals for the I/O interface.

The data bus transceivers control the direction of data transfer over the bus, multiplex data between the 32 -bit microprocessor data bus and the 8 -bit I/O data bus, and supplies buffering for the data bus lines.

The I/O bank-select decoder controls the enabling and multiplexing of the data bus transceivers.
30. 160 ns .
31. 320 ns .
32. I/O map base; word offset 66 H from the beginning of the TSS.
33. BASE +8 H ; LSB (bit 0 )
34. 1 .

## Section 16.7

35. Interrupt vector table; interrupt descriptor table.
36. Two words; four words.
37. Interrupt descriptor table register; $0000000003 \mathrm{FF}_{16}$.
38. B0H through B3H
39. (a) Active; (b) privilege level 2; (c) interrupt gate; (d) $\mathrm{B} 000 \mathrm{H}: 1000 \mathrm{H}$.
40. $010000_{16} ; 512$ bytes; 64 .
41. In the protected mode, the 80386 DX 's protection mechanism comes into play and checks are made to confirm that the gate is present; the offset is within the limit of the
interrupt descriptor table; access byte of the descriptor for the type number is for a trap, interrupt, or task gate; and to assure that a privilege level violation will not occur.
42. Divide error, debug, breakpoint, overflow error, bounds check, invalid opcode, coprocessor not available, interrupt table limit to small, coprocessor segment overrun, stack fault, segment overrun, and coprocessor error.
43. Faults, traps, and aborts.
44. Vectors 0 through 31.
45. Fault
46. Any attempt to access an operand that is on the stack at an address that is outside the current address range of the stack segment.
47. Double fault, invalid task state segment, segment not present, general protection fault, and page fault.

## Section 16.8

48. INTR
49. $\mathrm{DP}_{0}, \mathrm{DP}_{1}, \mathrm{DP}_{2}, \mathrm{DP}_{3}$, and PCHK----; even parity.
50. BRDY---- $=0$.
51. Cache enable.
52. BOFF----
53. Four double words $=16$ bytes; BRDY---- $=0 ; 5$ clock cycles.
54. This means that the code or data that is read from memory is copied into the internal cache; KEN---- $=0 ; 4$ double words $=16$ bytes.
55. Near to zero-wait-state operation even though the system employs a main memory subsystem that operates with one or more wait states.
56. First level.
57. A bus cycle that reads code or data from the cache memory is called a cache hit.
58. $93.2 \%$
59. 0.203 wait states/bus cycle.
60. Four-way set associative.
61. 8 Kbytes ; line of data $=128$ bits ( 16 bytes).
62. Write-through.
63. The contents of the internal cache are cleared. That is, the tag for each of the lines of information in the cache is marked as invalid.
64. Alignment check; gate 17.

## Section 16.9

65. Clock doubling and write-back cache.
66. Snooping.
67. Modify/exclusive/shared/invalid (MESI) protocol.
68. HITM---- and 0 .
69. The WBWT---- input must be held at logic 1 for at least two clock periods before and after a hardware reset.
70. Clock tripling and 16 Kbyte on-chip cache memory.
71. $435 / 68=6.4$.
72. 3.3 V dc.

## Section 16.10

73. 3 million transistors.
74. 3.3 V dc .
75. $\mathrm{D}_{45}$ is at pin $\mathrm{A} 21 ; \mathrm{A}_{3}$ is at pin T17.
76. $8,8,1$.
77. Data parity and address parity; APCHK---- $=0$ address parity error and PCHK---- $=$ 0 data parity error.
78. The current bus cycle has not run correctly to completion.
79. I/O write.
80. It is a pipelined bus cycle.
81. Two-way set associative.
82. 8Kbyte code cache; 8Kbyte data cache.
83. 256 bits ( 32 bytes).
84. The write-through update method is used to write the data to external memory.
85. Read hits access the cache, read misses may cause replacement, write hits update the cache, writes to shared lines and write misses appear externally, write hits can change shared lines to exclusive under control of WB/WT----, and invalidation is allowed.

## Section 16.11

86. Pentium ${ }^{\mathrm{R}}$ Pro processor
87. 5.5 million; 4.5 million.
88. 256 Kbyte , and 512 Kbyte .
89. Both the code and data caches are 16 Kbytes in size; they are organized four-way setassociative.
90. 182

## Section 16.12

91. Celeron ${ }^{\text {TM }}$ processor.
92. 386,213 .
93. $533 \mathrm{Mbytes} / \mathrm{sec}$.
94. 1400Mbytes/sec.
95. Single edge contact cartridge.
96. 4000 Mbytes/second

## Section 16.13

97. P6 microarchitecture; NetBurst ${ }^{\mathrm{TM}}$ microarchitecture.
98. Forty two million transistors.
99. $133 \mathrm{MHz} ; 400 \mathrm{MHz}$.
100. Execution trace cache.
